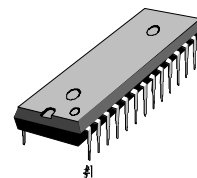# VIDEO AMP MERGED OSD PROCESSOR

The S1D2514X01 is a very high frequency video amplifier & wide range OSD processor 1 chip system with I^2C Bus control used in monitors. It contains 3 matched R/G/B video amplifiers with OSD processor and provides flexible interfacing to I^2C Bus controlled adjustment systems.

32-DIP-600A

FUNCTIONS

- R/G/B video amplifier
- OSD processor
- I^2C bus control
- Cut-off brightness control
- R/G/B sub contrast/cut-off control
- Half tone

ORDERING INFORMATION

Device	Package	Operating Temperature
S1D2514X01-D0B0	32-DIP-600A	-20 °C − +75 °C

FEATURES

VIDEO AMP PART

- 3-channel R/G/B video amplifier, 150MHz @f-3dB
- I^2C bus control items
    — Contrast control: -38dB
    - Sub contrast control for each channel: -12dB
    - Brightness control
    - OSD contrast control: -38dB
    - Cut-off brightness control (AC coupling)
    - Cut-off control for each channel (AC coupling)
    - Switch registers for SBLK and video half tone and CLP/BLK polarity selection and INT/EXT CLP selection
- Built in ABL (automatic beam limitation)
- Built in video input clamp, BRT clamp
- Built in video half tone (3mode) function on OSD pictures
- Capable of 8.0Vp-p output swing
- Improvement of rise & fall time (2.2ns)
- Cut-off brightness control
- Built in blank gate with spot killer
- Clamp pulse generator
- OSD intensity
- BLK, CLP polarity selection
- Clamp gate with anti OSD sagging

OSD PART

- Built in 1K-byte SRAM
- 256 ROM fonts (each font consists of 12×18 dots.)
- Full screen memory architecture
- Wide range PLL available (15kHz — 90kHz, Reference 800 X 600)
- Programmable vertical height of character
- Programmable vertical and horizontal positioning
- Character color selection up to 16 different colors (in a units of character)
- Programmable background color (up to 16 colors)
- Character blinking and shadowing
- Character scrolling
- 72MHz pixel frequency from on-chip PLL (Reference 800 ± 600)
- Full white pattern generation function

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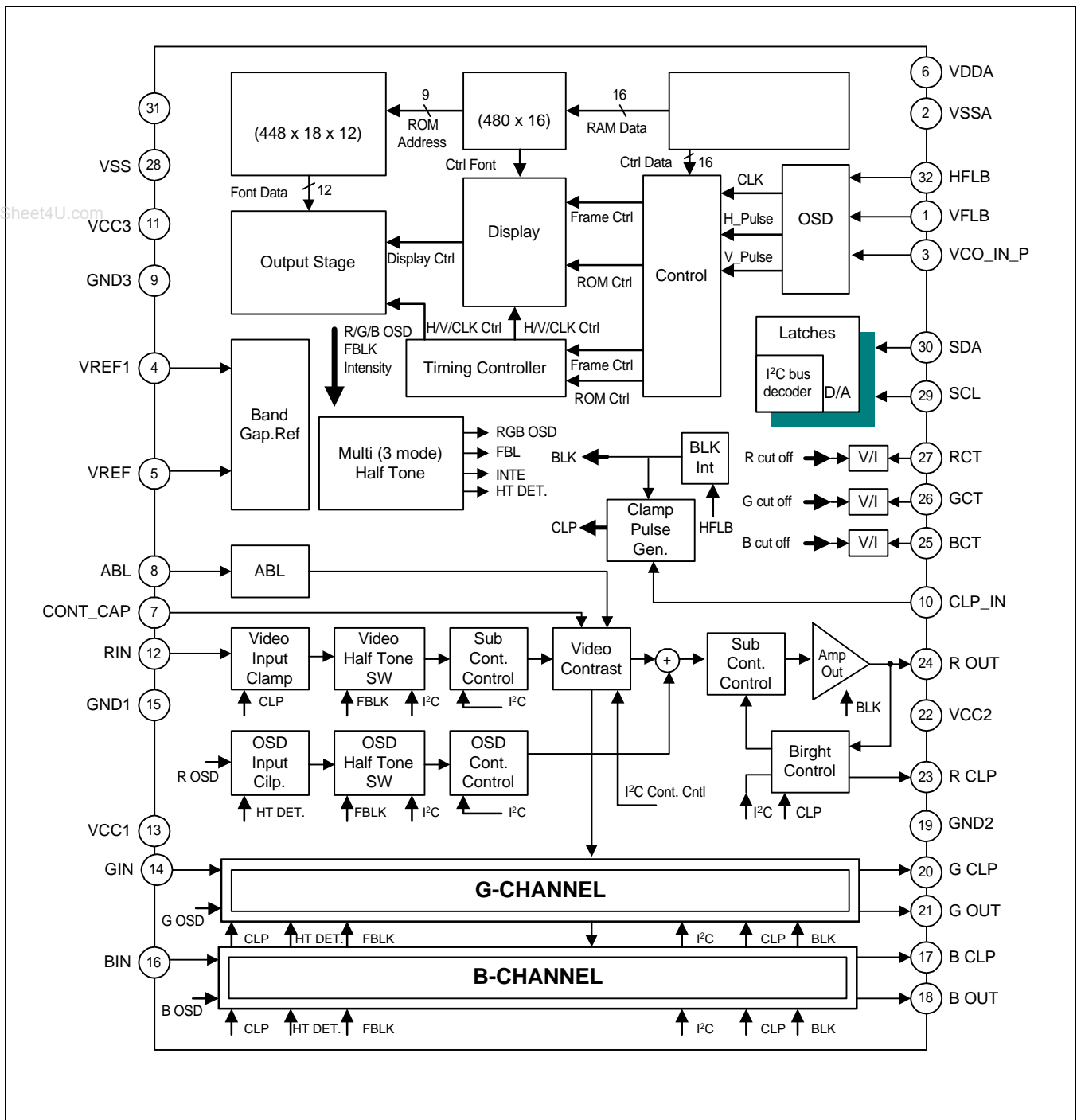**ELECTRONICS**

BLOCK DIAGRAM

Figure 1. Functional Block Diagram

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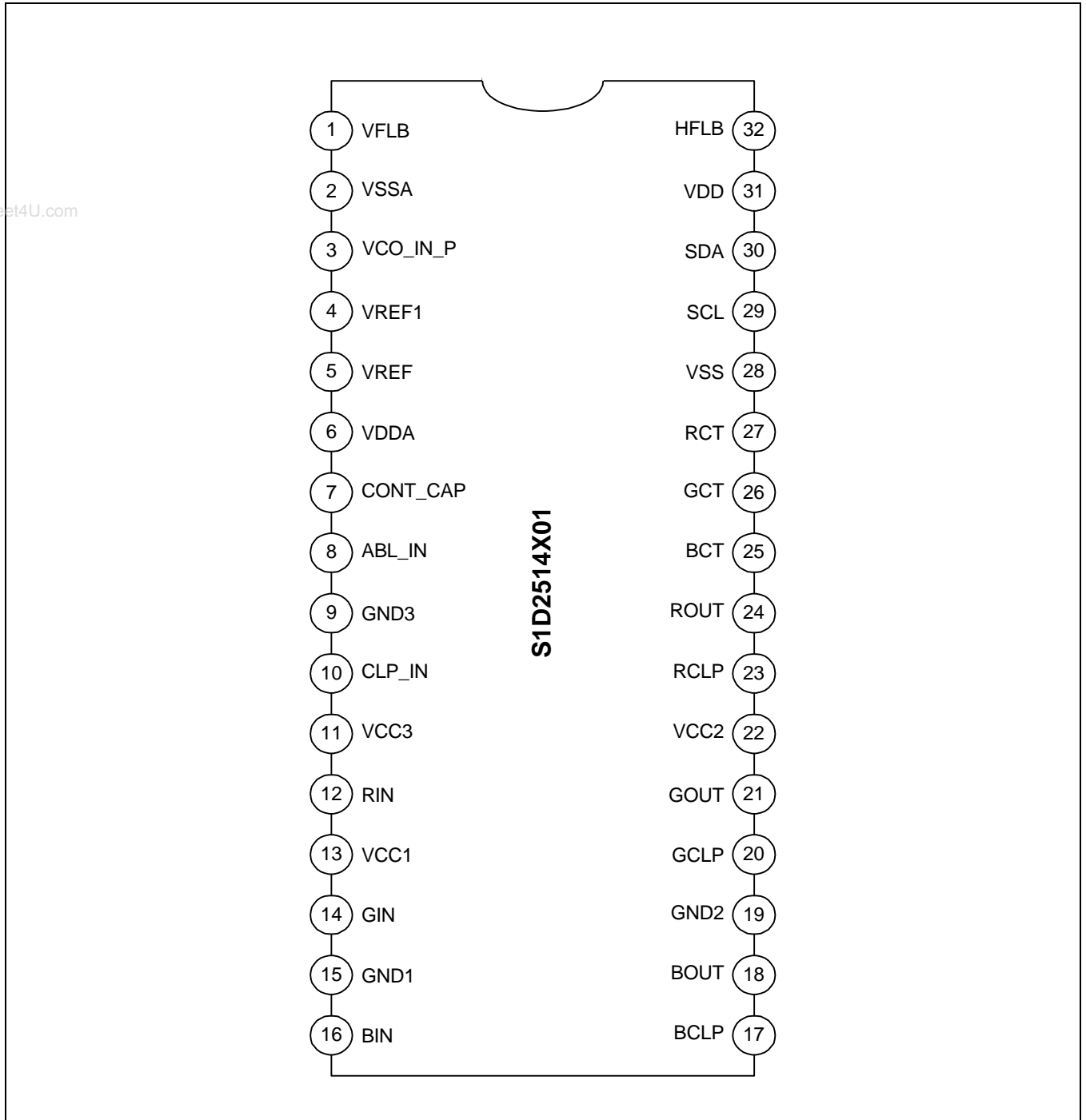
PIN CONFIGURATION

Figure 2. Pin Configuration

Table 1. Pin Configuration

Pin No.	Symbol	I/O	Configuration
1	VFLB	I	Vertical flyback signal
2	VSSA	-	Ground (PLL part)
3	VCO_IN_P	I	This voltage is generated at the external loop filter and goes into the input stage of the VCO.
4	VREF1	O	Charge pump output
5	VREF	O	PLL regulator filter
6	VDDA	-	+5V supply voltage for PLL part
7	CONT_CAP	-	Contrast control for AMP part
8	ABL	-	Auto beam limit.
9	GND3	-	Ground for video AMP part(for AMP control)
10	CLP_IN	-	Video clamp pulse input
11	VCC3	-	+12V supply voltage for video AMP part(for AMP control)
12	RIN	I	Video signal input (red)
13	VCC1	-	+12V supply voltage for video AMP(for main video signal process)
14	GIN	I	Video signal input (green)
15	GND1	-	Ground for video AMP part(for main video signal process)
16	BIN	I	Video signal input (blue)
17	BCLP	-	B output clamp cap
18	BOUT	O	Video signal output (blue)
19	GND2	-	Ground for video AMP part(for video output drive)
20	GCLP	-	G output clamp cap
21	GOUT	O	Video signal output (green)
22	VCC2	-	+12V supply voltage for video AMP part(for video output drive)
23	RCLP	-	R output clamp cap
24	ROUT	O	Video signal output (red)
25	BCT	-	B cut-off output
26	GCT	-	G cut-off output
27	RCT	-	R cut-off output
28	VSS	-	Ground for digital part
29	SCL	I	Serial clock (I^2C)
30	SDA	I/O	Serial data (I^2C)
31	VDD	-	+5V supply voltage for digital part
32	HFLB	I	Horizontal flyback signal

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PIN DESCRIPTION

Table 2. Pin Description

Pin No	Pin Name	Schematic	Description
1 32	VFLB HFLB		FLB signal is in TTL level Multi polarity input
3 4 5	VCO_IN_P VPEF1 VREF		PLL loop filter output BandGap ref. output
7	Contrast cap (CONT_CAP)		Contrast cap range (0.1uF — 5uF)
8	ABL_IN		ABL input DC range (1 — 4.5V)

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Table 2. Pin Description (Continued)

Pin No	Pin Name	Schematic	Description
10	CLP_IN		Multi polarity input Clamp gate pulse TTL level input
12 14 16	Red video input (RIN) Green video input (GIN) Blue video input (BIN)		Max input video signal is 0.7 Vpp
17 20 23	Blue (B clamp cap) Green (G clamp cap) Red (R clamp)		Brightness controlling actives by charging and discharging of the external cap. (0.1µF) (During clamp gate)

Table 2. Pin Description (Continued)

Pin No	Pin Name	Schematic	Description
18	Blue video output (BOUT)		Video signal output
21	Green video output (GOUT)		
24	Red video output (ROUT)		
27	Red cut-off control (RCT)		Cut-off control output
26	Green cut-off control (GCT)		
25	Blue cut-off control (BCT)		
29	SCL		Serial clock input port of I^{2}C bus
30	SDA		Serial data input port of I^{2}C bus

ABSOLUTE MAXIMUM RATINGS [see 1]

(Ta = 25 $^\circ$C)

Table 3. Absolute Maximum Ratings

No	Item	Symbol	Value			Unit
			Min	**Typ**	**Max**	
1	Maximum supply voltage	V_{CC}	-	-	13.2	V
		V_{DD}	-	-	6.5	
2	Operating temperature [see 2]	Topr	-20	-	75	$^\circ$C
3	Storage temperature	Tstg	-65		150	$^\circ$C
4	Operating supply voltage	V_{CCop}	11.4	12.0	12.6	V [see 3]
		V_{DDop}	4.75	5.00	5.25	
5	Power dissipation	P_D	-	-		W

THERMAL & ESD PARAMETER

Table 4. Thermal & ESD Parameter

No	Item	Symbol	Value			Unit
			Min	**Typ**	**Max**	
1	Thermal resistance (junction-ambient)	θja	-	48	-	$^\circ$C/W
2	Junction temperature	Tj	-	150	-	$^\circ$C
3	Human body model (C = 100p, R = 1.5k)	HBM	2	-	-	KV
4	Machine model (C = 200p, R = 0)	MM	300	-	-	V
5	Charge device model	CDM	800	-	-	V

ELECTRICAL CHARACTERISTICS

DC ELECTRICAL CHARACTERISTICS

(Tamb = 25 °C, V_{CC} = 12V, V_{DD} = V_{DDA} = 5V, ABL input voltage = 5V, HFLB input signal = S3, load resistors = 470Ω, except OSD part current 35mA, unless otherwise stated)
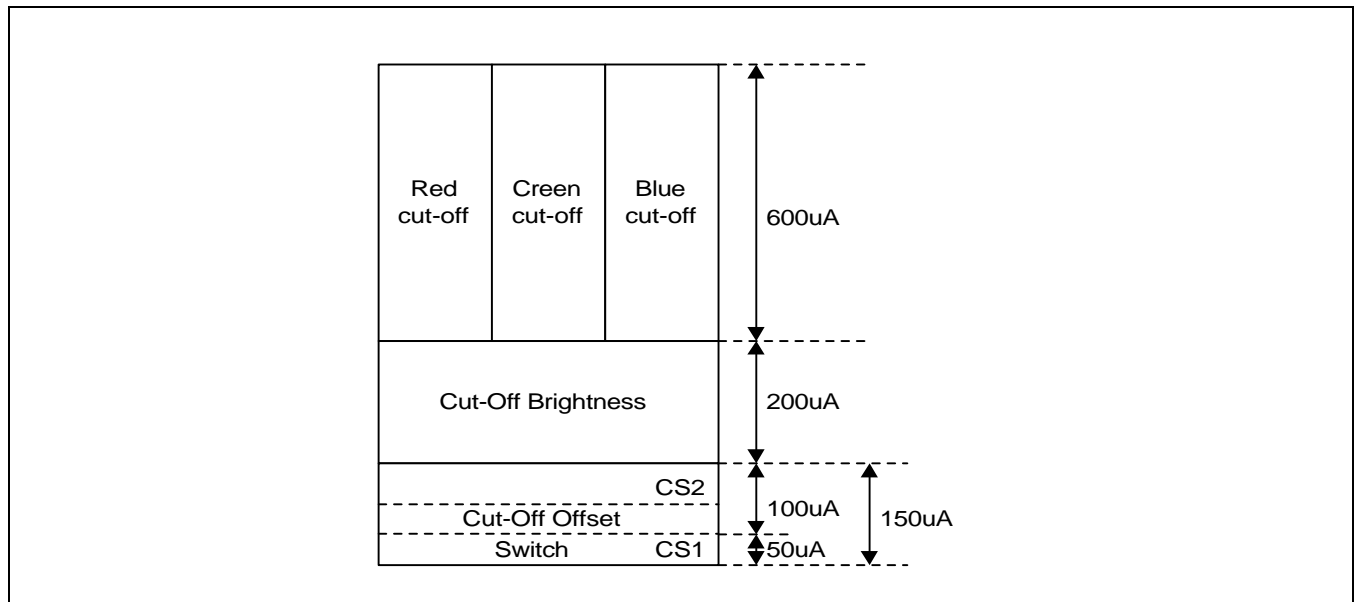
Table 5. DC Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Supply current	I_{CC} (see 4)		100	125	130	mA
Minimum supply current	I_{CC} min	V_{CC} = 11.4V	95	110	120	mA
Maximum supply current	I_{CC} max	V_{CC} = 12.6V	105	130	140	mA
ABS supply current	I_{CC} abs	V_{CC} = 13.2V	-	-	175	mA
Video input bias voltage	V bias		1.8	2.1	2.4	V
Video black level voltage (POR)	V blackpor		1.20	1.50	1.80	V
Black level voltage channel difference (POR)	Δ V blackpor (see 5)		Δ 10	-	-	%
Video black level voltage (FFH)	V blackff	04 = FFH (see 13)	2.2	2.7	3.2	V
Black level voltage channel difference (FFH)	Δ V blackff		Δ 10	-	-	%
Video black level voltage (00H)	V black00	04 = 00H	-	0.2	0.5	V
Black level voltage channel difference (00H)	Δ V black00		Δ 10	-	-	%
Spot killer voltage	Vspot	V_{CC} = Var.	9.20	10.4	11.2	V
Cut-off current (FFH)	ICTff	Pin25, 26, 27 = 12V 09 — 0B: FFH 0C: 00H	500	625	750	μA
Cut-off current (00H)	ICT00	Pin25, 26, 27 = 12V 09 — 0C: 00H	-	2.0	5.0	μA
Cut-off brightness current (FFH)	ICTBRTff	Pin25, 26, 27 = 12V 09 — 0B: 00H 0C: FFH	100	180	260	μA
Cut-off brightness current (80H)	ICTBRT80	Pin25, 26, 27 = 12V 09 — 0B: 00H 0C: 80H	50	90	130	μA
Cut-off offset current 1	ICS1	Pin25, 26, 27 = 12V 09 — 0C: 00H 0E: 11H	25	50	75	μA

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Table 5. DC Electrical Characteristics (Continued)

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
Cut-off offset current 2	ICS2	Pin25, 26, 27 = 12V 09 — 0C: 00H 0E: 12H	50	100	130	µA
Soft BLK output voltage	Vsblk	0D: 80H 0E: 14H	-	0.2	0.5	V
Clamp cap voltage (POR)	Vcap		6.0	7.0	8.0	V

Total external cut-off current range

AC ELECTRICAL CHARACTERISTICS

(Tamb = 25 °C, V_{CC} = 12V, V_{DD} = V_{DDA} = 5V, ABL input voltage = 5V, HFLB input signal = S3, load resistors = 470Ω, Vin = 0.7Vpp manually adjust video output pins 18, 21 and 24 to 4V DC for the AC test (see 11) unless otherwise stated (see 12))

Table 6. AC Electrical Characteristics

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
Contrast max. output voltage	Vcff	03, 05, 06, 07 = FFH 04, 08 — 0C = 80H RGB input = S1	5.0	5.7	6.4	Vpp
Contrast max. output channel difference	Δ Vcff		Δ 10	-	-	%
Contrast center output voltage	Vc80	03, 04, 08 — 0C = 80H 05, 06, 07 = FFH RGB input = S1	2.5	2.85	3.2	Vpp
Contrast center output channel difference	Δ Vc80		Δ 10	-	-	%
Contrast max. - Center attenuation	C	C = 20log (Vc80/Vcff)	-8	-6	-4	dB
Sub contrast center output voltage	Vd80	03 = FFH 04 — 0C = 80H RGB input = S1	2.3	2.6	2.9	Vpp
Sub contrast center output channel difference	Δ Vd80		Δ 10	-	-	%
Sub contrast min. output voltage	Vd00	03 = FFH, 05— 07: 00H 04, 08 — 0C = 80H RGB input = S1	1.3	1.6	1.9	Vpp
Sub contrast min. output channel difference	Δ Vd00		Δ 10	-	-	%
Sub contrast max. - min. attenuation	D	D = 20log (Vd00/Vcff)	-14	-12	-10	dB
ABL control range	ABL	(see 15)	-12	-10	-8	dB
R/G/B video rising time [7]	tr (video)	03, 05 — 07: FFH 04, 08 — 0C: 80H RGB input = S2	-	2.2	2.8	ns
R/G/B video falling time [7]	tf (video)		-	2.2	2.8	ns
R/G/B blank output rising time [7]	tr (blank)	POR HFLB: S4	-	6.0	12.0	ns
R/G/B blank output falling time [7]	tf (blank)		-	8.0	15.0	ns
R/G/B video band width [7, 8]	f (-3dB)	(see 16)	150	-	-	MHz
Video AMP 50MHz cross talk	CT_50M [7, 9]	(see 17)	-	-25	-20	dB
Video AMP 130MHz cross talk	CT_130M [7, 9]	(see 18)	-	-15	-10	dB
Absolute gain match	Avmatch [6]		-1	-	1	dB
Gain change between amplifier	Avtrack [7]		-1	-	1	dB

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OSD ELECTRICAL CHARCTERISTICS

(Tamb = 25 °C, V_{CC} = 12V, V_{DD} = V_{DDA} = 5V, HFLB input voltage = S3, load rosistors = 470Ω, V-AMP test registorš FBLK, OSD input conditions unless otherwise stated)
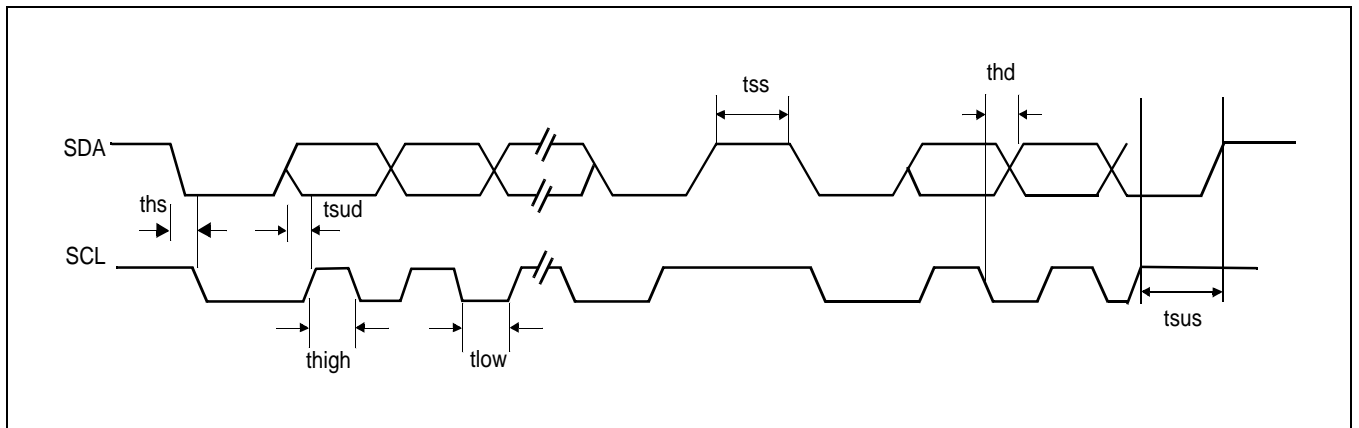
Table 7. OSD Electrical Chaacteristics

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
OSD contrast max. output voltage	Vocff	08 = FFH OSD RGB output conditions	5.4	6.4	7.4	Vpp
OSD contrast max. output channel difference	Δ Vocff		Δ 10	-	-	%
OSD contrast center output voltage	Voc80	08 = 80H OSD RGB output conditions	2.7	3.2	3.7	Vpp
OSD contrast center output channel difference	Δ Voc80		Δ 10	-	-	%
R/G/B OSD rising time	tr (OSD)	08: FFH	-	4.0	5.0	ns
R/G/B OSD falling time	tf (OSD)		-	4.0	5.0	ns
HT video level	HTvideo	ABL = 6V RGB input = S1 03, 05 — 08: FFH 0D: 01H OSD black conditions input HTvideo = 20log($V_{htvideo}$/V_{cff})	-6.0	-4.5	-3.0	dB
HT video output channel difference	Δ HTvideo		Δ 15	-	-	%
HT OSD level	HTosd	ABL = 6V 05 — 08: FFH 0D: 0FH OSD white condition input HTosd = 20log (V_{htosd}/V_{ocff})	-7.0	-5.5	-4.0	dB
HT OSD output channel difference	Δ HTosd		Δ 15	-	-	%

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OPERATION TIMINGS

Table 8. Operation Timings

Parameter	Symbol	Min	Typ	Max	Unit
Input Signal HFLB, VFLB					
Horizontal flyback signal frequency	f_{HFLB}	-	-	120	kHz
Vertical flyback signal frequency	f_{VFLB}	-	-	200	Hz
I^{2}C Interface SDA, SCL (Refer to Figure 3)					
SCL clock frequency	f_{SCL}	-	-	300	kHz
Hold time for start condition	t_{hs}	500	-	-	ns
Set up time for stop condition	t_{sus}	500	-	-	ns
Low duration of clock	t_{low}	400	-	-	ns
High duration of clock	t_{high}	400	-	-	ns
Hold time for data	t_{hd}	0	-	-	ns
Set up time for data	t_{sud}	500	-	-	ns
Time between 2 access	t_{ss}	500	-	-	ns
Fall time of SDA	t_{fSDA}	-	-	20	ns
Rise time of both SCL and SDA	t_{rSDA}	-	-	-	ns

Figure 3. I^{2}C Bus Timing Diagram

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OSD PART DC ELECTRICAL CHARACTERISTICS

(Ta = 25 C, V_{DDA} $_{DD}$ = 5V)

Parameter	Symbol			Typ	Max	
Supply voltage	V	4.75	5.00			V
Supply current	I_{DD}			-	25	
Input voltage	V	$0.8V_{DD}$			-	V
	$_{IL}$	-			V_{SS}	V
Output voltage	$_{OH}$	0.8V		-	-	
±1mA)	V_{OL}			-	V + 0.4	V
	I_{IL}			-	10	A
VCO input voltage	$_{VCO}$			2.5		

NOTES:

1. Absolute maximum rating indicates the limit beyond which damage to the device may occur.

2. Operating ratings indicate conditions for which the device is functional but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the electrical characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

3. VCC supply pins 11, 13, and 22 must be externally wired together to prevent internal damage during VCC power on/off cycles.

4. The supply current specified is the quiescent current for VCC1/VCC2 and VCC3 with RL = ∞, The supply current for VCC2 (pin 22) also depends on the output load.

5. Output voltage is dependent on load resistor. Test circuit uses RL = 470Ω

6. Measure gain difference between any two amplifiers Vin = 700mVpp.

7. When measuring video amplifier bandwidth or pulse rise and fall times, a double sided full ground plane printed circuit board without socket is recommended. Video amplifier 50MHz cross talk test also requires this printed circuit board. The reason for a double sided full ground plane PCB is that large measurement variations occur in single sided PCBs.

8. Adjust input frequency from 10MHz (AV max reference level) to the -3dB frequency (f -3dB).

9. Measure output levels of the other two undriven amplifiers relative to the driven amplifier to determine channel separation. Terminate the undriven amplifier inputs to simulate generator loading. Repeat test at fin = 50MHz for cross talk 50MHz.

10. A minimum pulse width of 200 ns is guaranteed for a horizontal line of 15kHz. This limit is guaranteed by design. if a lower line rate is used a longer clamp pulse may be required.

11. During the AC test the 4V DC level is the center voltage of the AC output signal. For example. If the output is 4Vpp the signal will swing between 2V DC and 6V DC.

12. These parameters are not tested on each product which is controlled by an internal qualification procedure.

13. The conditions blocks 03, 04, 05... etc. signify sub address'0F03, 0F04, 0F05... etc.

14. Sub address 0F03, 0F05 — 0F07: FFH
    0F04, 0F08 — 0F0C: 80H
    RGB input = S1,
    When the ABL input voltage is 0V, the R/G/B's output voltage is VR/VG/VB and uses the formula ABLR = 20log (VR/V$_{cffR}$)

15. OSD TST mode = High, CLP operation off,
    RGB input = S5 (frequency sweep),
    RGB input clamp cap = 2.1V DC,
    RGB clamp cap (pin 23/20/17) = Vcap voltage (7.0V),
    S5's frequency 1MHz → 130MHz sweep, -3dB point = 20log (V$_{130MHz}$/V$_{1MHz}$)
    03, 05 — 07: FFH
    04, 08 — 0C: 80H
    0F: 80H

16. OSD TST mode = High, CLP operation off,
    RGB input clamp cap = 2.1V DC,
    RGB clamp cap (pin 23/20/17) = Vcap voltage (7.0V),
    03, 05 — 07: FFH
    04, 08 — 0C: 80H
    0F: 80H
    R input = S5 (50MHz)
    CT_50M = 20log (V$_{outG}$/V$_{outR}$) or 20log (V$_{outB}$/V$_{outR}$)

17. OSD TST mode = High, CLP operation off,
    RGB input clamp cap = 2.1V DC,
    RGB clamp cap (pin 23/20/17) = Vcap voltage (7.0V),
    03, 05 — 07: FFH
    04, 08 — 0C: 80H
    0F: 80H
    R input = S5 (130MHz)
    CT_150M = 20log (V$_{outG}$/V$_{outR}$) or 20log (V$_{outB}$/V$_{outR}$)

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TEST SIGNAL FORMAT

Table 10. Test Signal Format

Signal Name	Input Signal Formal	Signal Description
S1	[V] Video Sync 4uS [t]	Video gain measurement Video = 1MHz/0.7Vpp Sync = 50kHz
S2	[V] 0.7 Vpp f = 200kHz Duty = 50% [t]	Video Tr/Tf measurement f = 200kHz V = 0.7Vpp Duty = 50%
S3	[V] t = 2uS f = 50kHz [t]	HFLB (posi & nega.) input f = 50kHz t = 2uS V = 0V/5V
S4	[V] 5V 0V f = 200kHz Duty = 50% [t]	OSD level measurement Blank Tr/Tf measurement f = 50kHz V = 0V/5V
S5	[V] Vi Vref [t]	Crosstalk test Bandwidth measurement 1MHz/10MHz/50MHz/130MHz Vref = input clamp voltage Vi = 0.7Vpp

- S1, S2 signals low level must be synchronized with the S3 signals sync. term.
- The input signal level uses the IC pin as reference.

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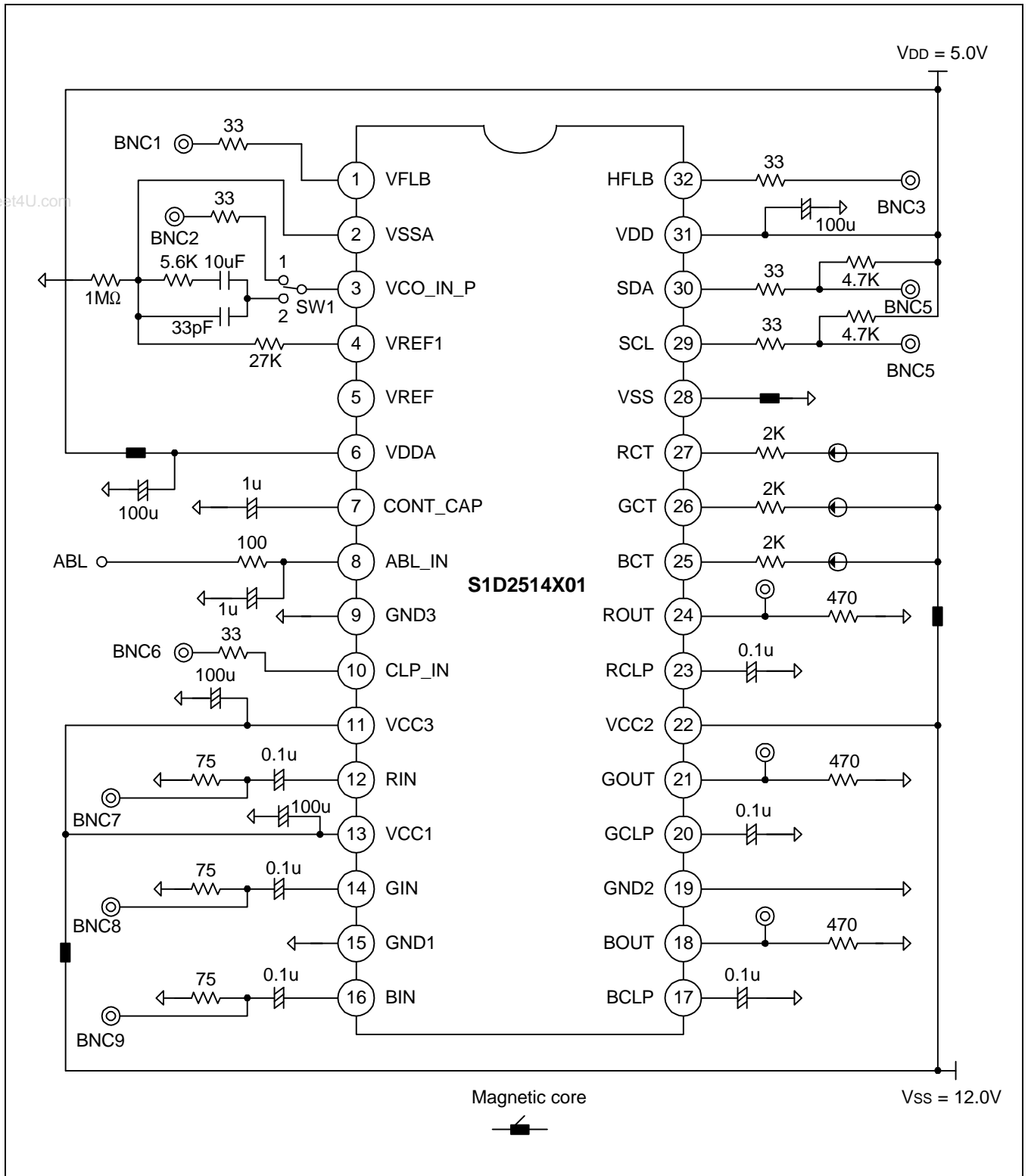
TEST CIRCUIT

Figure 4. Test Circuit

FUNCTIONAL DESCRIPTIONS

DATA TRANSMISSION

The interface between S1D2514X01 and MCU follows the I²C protocol. After the starting pulse, the transmission takes place in the following order: Slave address with R/W bit, 2-byte register address, 2-byte data, and stop condition. an acknowledge signal is received for each byte, excluding only the start/stop condition. The 2-byte register address is composed of an 8-bit row address, and an 8-bit column address. The order of transmission for a 2-byte register address is 'Row address → Column address'. The 2 bytes of data is because S1D2514X01 has a 16-bit base register configuration. S1D2514X01's slave address is BAh. It is BBh in read mode, and BAh in write mode.

- **Address Bit Pattern for Display Registers Data**
  (a) row address bit pattern
  R3 - R0: Valid data for row address

A15	A14	A13	A12	A11	A10	A9	A8
X	X	X	X	R3	R2	R1	R0

  (b) Column address bit pattern
  C4 - C0: Valid data for column address

A7	A6	A5	A4	A3	A2	A1	A0
X	X	X	C4	C3	C2	C1	C0

  X:Don't care bit

- **Data Transmission Format**

Start → Slave address → ACK → Row address → ACK → Column address → ACK
Data byte N → ACK → Data byte N+1 → ACK → Stop
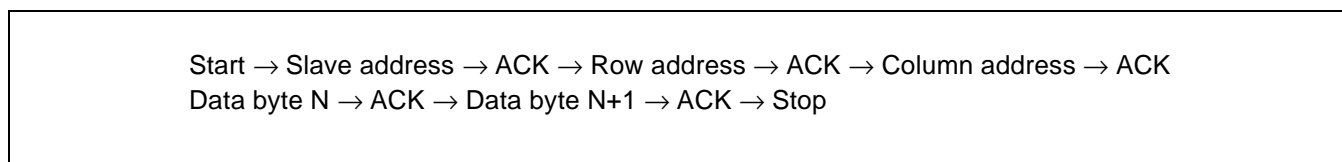
Figure 5. Data Transmission Format at Writing Operation

Start → Slave address → ACK → Row address → ACK → Column address → ACK → Stop
Start → Slave address → ACK → Data byte N → ACK → Data byte N+1 → ACK → Stop
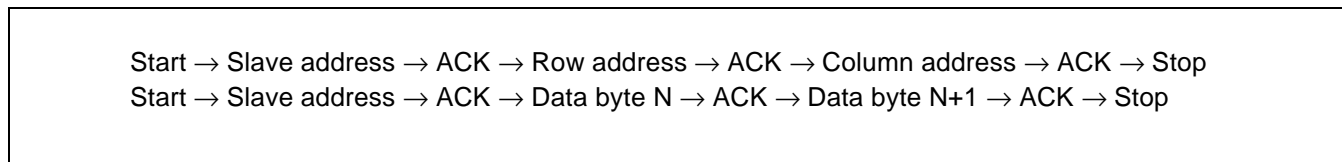
Figure 6. Data Transmission Format at Reading Operation

17

• **SDA / SCL Signal At Communication**
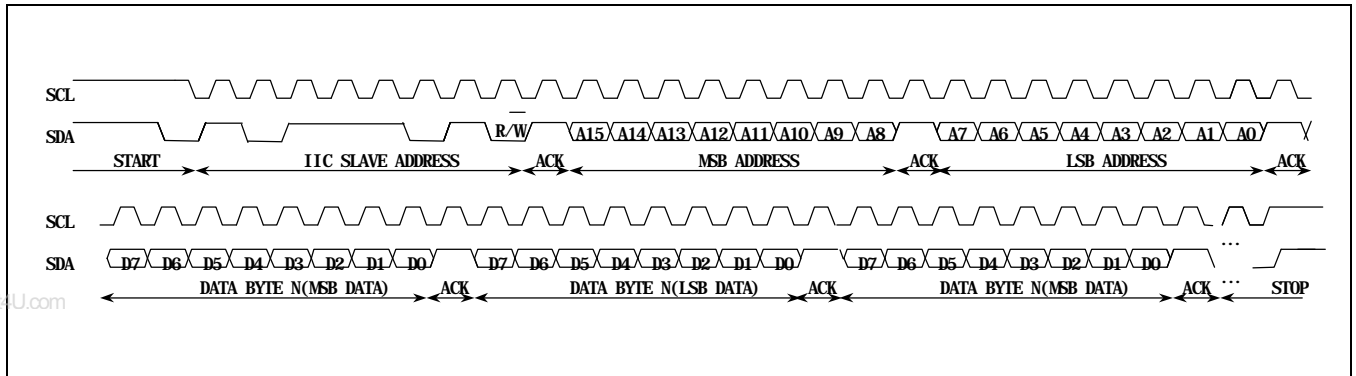
Figure 7. SDA line and SCL line (Write Operation)
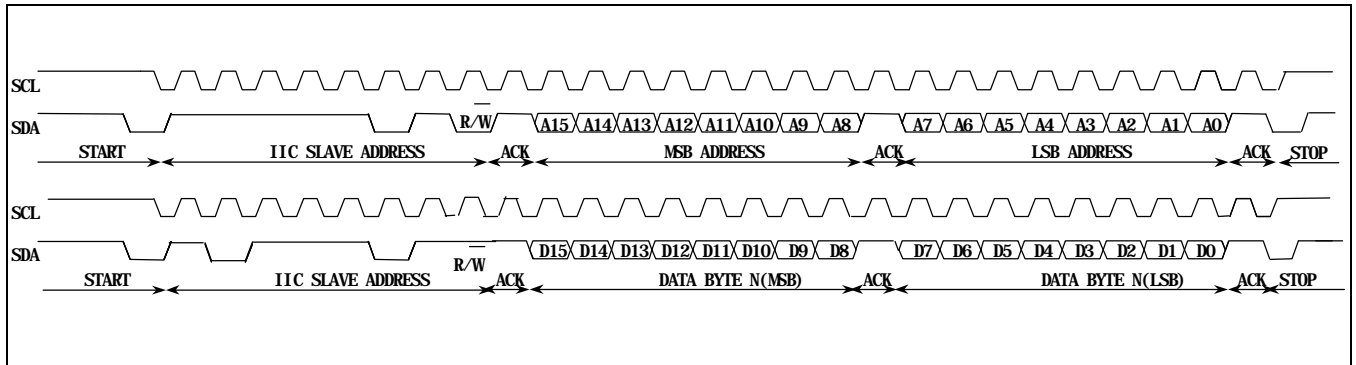
Figure 8. SDA line and SCL line (Read Operation)

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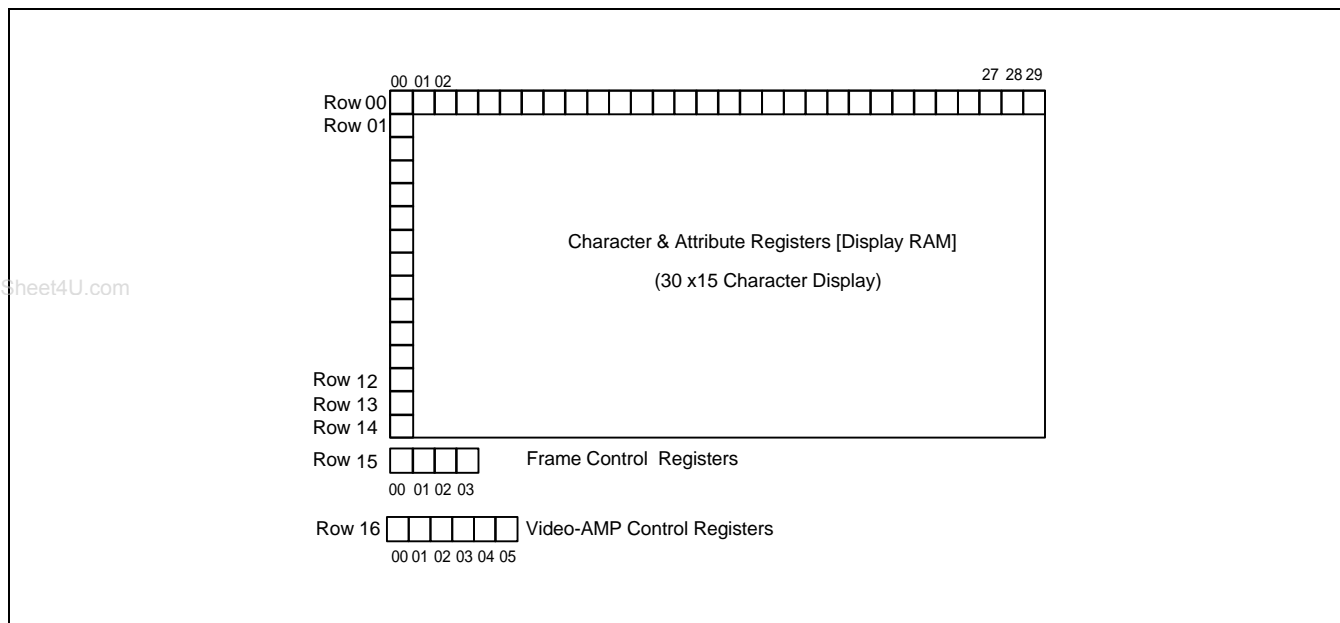
MEMORY MAP

Figure 9. Memory Map of Display Registers

The display RAM's address of the row and column number are assigned in order. The display RAM is composed of 3 register groups (character & attribute register, frame control register and V-AMP control register).

The display area in the monitor screen is 30 column $\times$ 15 row, so the related character & attribute registers are also 30 column $\times$ 15 row. Each register has a character address and characteristics corresponding to the display location on the screen, and one register is composed of 16 bits. The lower 8 bits select the font from the 256 ROM fonts, and the upper 8 bits give font characteristics to the selected font.

The frame control registers are in the 16th row. It controls OSD's display location, character height and scroll in units of frame.

The V-AMP control registers are also located in the 17th row.

REGISTER DESCRIPTION

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Character & Attribute Register: Row00 ~ 14, Column00 ~ 29

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
Blink	SHA	RB	RG	RR	CB	CG	CR	C7	C6	C5	C4	C3	C2	C1	C0

CTL1   CTL0

Extended Code   Character Attribute   Character Code (256 fonts)
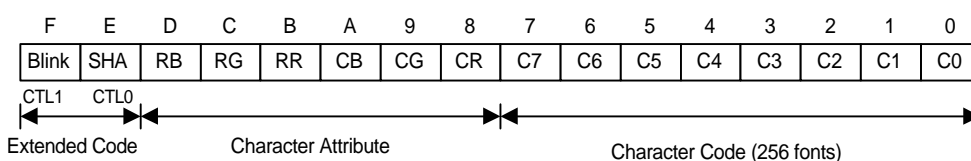
Frame Control Register 0: Row15, Column00

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	FullW	EX-EN	BGEN	ScrEN	ScrT	BliEN	BliT	Erase	EN
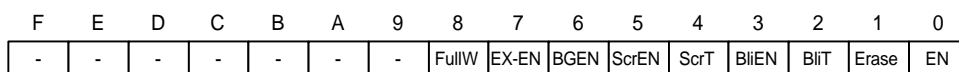
Frame Control Register 1: Row15, Column01

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
CP1	CP0	Fpll	HF2	HF1	HF0	dot1	dot0	HPOL	VPOL	CH5	CH4	CH3	CH2	CH1	CH0

PLL Control   Polarity   Character Height Control
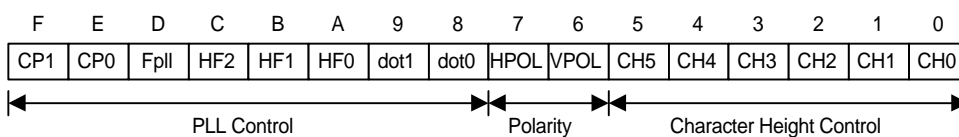
Frame Control Register 2: Row15, Column02

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
HP7	HP6	HP5	HP4	HP3	HP2	HP1	HP0	VP7	VP6	VP5	VP4	VP3	VP2	VP1	VP0

Horizontal Start Posiotion   Vertical Start Posiotion
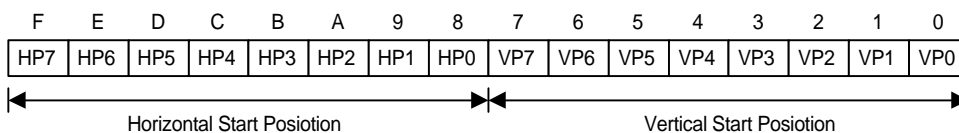
Frame Control Register 3: Row15, Column03

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
Blink	SHA	RINT	CINT	Blink	SHA	RINT	CINT	Blink	SHA	RINT	CINT	Blink	SHA	RINT	CINT

CTL11   CTL10   CTL01   CTL00

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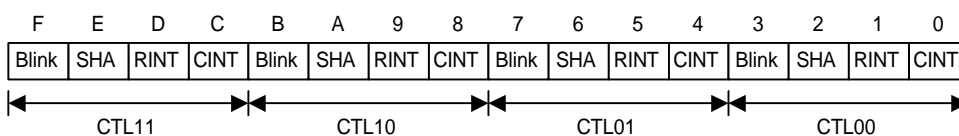
Video AMP Control Register: Row 16, Column 00 - 05

Column 00

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
BRT7	BRT6	BRT5	BRT4	BRT3	BRT2	BRT1	BRT0	VC7	VC6	VC5	VC4	VC3	VC2	VC1	VC0

Brightness Control | Contrast Control

Column 01

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
GSB7	GSB6	GSB5	GSB4	GSB3	GSB2	GSB1	GSB0	RSB7	RSB6	RSB5	RSB4	RSB3	RSB2	RSB1	RSB0

G SUB Contrast Control | R SUB Contrast Control

Column 02

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
OSD7	OSD6	OSD5	OSD4	OSD3	OSD2	OSD1	OSD0	BSB7	BSB6	BSB5	BSB4	BSB3	BSB2	BSB1	BSB0

OSD Contrast Control | B SUB Contrast Control

Column 03

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
GWB7	GWB6	GWB5	GWB4	GWB3	GWB2	GWB1	GWB0	RWB7	RWB6	RWB5	RWB4	RWB3	RWB2	RWB1	RWB0

G Cut-off Control | R Cut-off Control

Column 04

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
CUT7	CUT6	CUT5	CUT4	CUT3	CUT2	CUT1	CUT0	BWB7	BWB6	BWB5	BWB4	BWB3	BWB2	BWB1	BWB0

Cut-off Brightness Control | B Cut-off Control

Column 05

F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0
CLPS	CLPP	BLKP	CS2	CS1	HG3	HR3	HB3	SB	HG2	HR2	HB2	HG1	HR1	HB1	HT

' - '; Dont care bit

Figure 10. Register Description

Table 11. Register Description

Registers	Bits	Description
Character & Attribute Registers (Row 00 ~ 14, Column 00 ~ 29)	C7 — C0 (Bit 7 — 0)	Character code address This is the address of 256 ROM fonts.
	CB, CG, CR (Bit A — 8)	Character color The character color is chosen from 16 colors using these 3 bits and the frame control register 3̓s CINT bit.
	RB, RG, RR (Bit D — B)	Raster color is determined by these bits. The raster color is chosen from out of 16 colors using these 3 bits and the frame control register 3̓s RINT bit.
	SHA / CTL0 (Bit E)	Character shadowing / CTL0(Extended Code) If you set the frame control register 0̓s EX-EN bit to '0', this bit carries out character shadowing feature.(If SHA bit is '1', the character shadowing is shown) If you set the frame control register 0̓s EX-EN bit to '1', this bit is used for extended code.
	Blink / CTL1 (BIt F)	Character blinking / CTL1(Extended Code) If you set the frame control register 0̓s EX-EN bit to '0', this bit carries out character blinking feature.(If Blink bit is '1', the character blinking feature is shown) If you set the frame control register 0̓s EX-EN bit to '1', this bit is used for extended code.

If you set the Frame Control Register 0̓s 'EX-EN' bit as '1', the Character & Attribute Register̓s 'SHA' and 'Blink' bits are used to call the Extended Code.

In other words, the combination of SHA and Blink bits can call four kind Extended Code 'CTL00', 'CTL01', 'CTL10' and 'CTL11', the CINT, RINT, SHA and Blink features can be carried out in a unit of character fonts.

Table 11. Register Description (Continued)

Registers	Bits	Description
Frame Control Registers - 0 (Row15, Column00)	EN (Bit 0)	OSD enable OSD is enabled when this bit is '1'. In other words, if this bit isn't '1'OSD is not output inspite of writing control data. We recommend that you enable the OSD after setting the control registers (such as the character & attribute register) because of video and OSD output timing.
	Erase (Bit 1)	RAM erasing If this bit is '1', the RAM data (character & attribute registers) is erased. The time spent in carrying out this operation is called erasing time, which can be calculated as follows. Erasing time = RAM clock $\times$ 480 (RAM cell no.) RAM clock = 12 dot clock Dot clock = 1/(dot frequency) Dot frequency = Horizontal frequency $\times$ resolution (mode) Therefore, the maximum erasing time value is: (Erasing Time)$_{MAX}$ = (12 $\times$ 480) / (15k $\times$ 320) = 1.2ms
	BliT (Bit 2)	Blink time control If this bit is '1', blink time is 0.5sec, and if not, 1sec.
	BliEN (Bit 3)	Blinking enable Blinking effect is controlled by this bit. If this bit is '1', blinking effect is enabled. If this bit is '0', a full OSD screen blinking effect is disabled.
	ScrT (Bit 4)	Scroll time control If this bit is '1', scroll time is 0.5sec, and if not, 1sec.
	ScrEN (Bit 5)	Scroll enable Scrolling effect is controlled by this bit. If this bit is '1', scrolling effect is enabled. You must remember that scrolling can be turned on/off only when OSD is enabled/disabled.
	BGEN (Bit 6)	Back ground enable If the BGEN bit is '1' and the raster color is black, the raster is transparent. That is, the video back ground is shown. If not, the OSD raster covers the video's back ground. Refer to other color effect.
	EX-EN (Bit 7)	Extended code enable If the EX-EN bit is '1', the Character & Attribute register's Blink, SHA bits carry out Extended Code features instead of Blink and SHA features.
	FullW (Bit 8)	Full white pattern enable If the FullW bit is '1', the full white pattern is displayed in the screen.

Table 11. Register Description

Registers	Bits	
Frame Control Registers - 1 Column01)	CH5 — CH0	Character height control While the purpose of VZ[1:0] (vertical character height) is to control the to output OSD of a uniform size even if the resolution changes. If you adjust the value in the range of CH = 18 ~ CH = 63, each line's repeating number line is repeated. For more information on repeating number selection, refer to character height.
	(Bit 6)	Polarity of vertical fly back signal words, this bit is set to '1' if active high, and '0' if active low.
	HPOL	Polarity of horizontal fly back signal If this bit is '1', HFLB's polarity is positive, and if '0', it is negative. In other
	dot1, dot0 (Bit 9, 8)	<table><tr><td>**Dot1**</td><td>**Dot0**</td><td></td></tr><tr><td>0</td><td>0</td><td></td></tr><tr><td>0</td><td>1</td><td></td></tr><tr><td>1</td><td>0</td><td></td></tr><tr><td>1</td><td>1</td><td></td></tr></table>As shown above, the number of dots per horizontal line is decided by a combination of these two bits.
	(Bit C — A)	Horizontal frequency This is related to the selection of DOT[1:0], so you can't numerically express the frequency range with only the HF[2:0] selection. For more
	FPLL (Bit D)	If this bit is '1', the OSD_PLL block's VCO operates at full range (4.8MHz - 96MHz). If it is '0', it operates within the region decided by the HF bit [C:A] the high region, you may set the FPLL bit to '1'.

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Table 11. Register Description (Continued)

Registers	Bits	Description
Frame Control Registers - 1 (Row15, Column01)	CP1, CP0 (Bit F, E)	Charge pump output current control This is the PLL block's internal phase detector output status, converted into current. Refer to PLL control. <table><tr><th>CP1</th><th>CP0</th><th>Charge Pump Current</th></tr><tr><td>0</td><td>0</td><td>0.50 mA</td></tr><tr><td>0</td><td>1</td><td>0.75 mA</td></tr><tr><td>1</td><td>0</td><td>1.00 mA</td></tr><tr><td>1</td><td>1</td><td>1.25 mA</td></tr></table> The output is decided by the combination of these two bits.

The purpose of bits 'HPOL', and 'VPOL' is to provide flexibility when using the S1D2514X01 IC. No matter which polarity you choose for the input signal, the IC will handle them identically, so you can select active high or active low according to your convenience.

Tabel 4. Register Description (Continued)

Registers	Bits	Description
Frame Control Registers - 2 (Row 15, Column 02)	VP7 — VP0 (Bit 7 — 0)	Vertical start position control (= VP[7:0] × 4)
		Signifies top margin height from the V-Sync reference edge.
	HP7 — HP0 (Bit F — 8)	Horizontal start position control (= HP[7:0] × 6)
		Signifies delay of the horizontal display from the H-Sync reference edge to the character's 1st pixel location.
Frame Control Registers - 3 (Row 15, Column 03)	CTL 00 (Bit 3 — 0)	Extended code
		In case the EX-EN bit is '1' and the Character & Attribute register's E and F bits are '0', these bits have meanings.
		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.
	CTL 01 (Bit 7 — 4)	Extended code
		In case the EX-EN bit is '1' and the Character & Attribute register's E bit is '1' and F bit is '0', these bits have meanings.
		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.
	CTL 10 (Bit B — 8)	Extended code
		In case the EX-EN bit is '1' and the Character & Attribute register's E bit is '0' and F bit is '1', these bits have meanings.
		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.

Tabel 4. Register Description (Continued)

Registers	Bits	Description
Frame Control Registers - 3 (Row 15, Column 03)	CTL 11 (Bit F — C)	Extended code
		In case the EX-EN bit is '1' and the Character & Attribute registers E and F bits are '1', these bits have meanings.
		If you set the CINT(character color intensity) bit '1', the character color intensity feature is carried out.
		If you set the RINT(raster color intensity) bit '1', the raster color intensity feature is carried out.
		If you set the SHA(character shadowing) bit '1', the character shadowing feature is carried out.
		If you set the Blink(character blinking) bit '1', the character blinking feature is carried out.

Tabel 4. Register Description (Continued)

Registers	Bits	Description
V-AMP Control Registers - 0 (Row 16, Column 00)	VC7 — VC0 (Bit7 — 0)	The contrast adjustment is made by contrdling simultaneously the gain of three internal variable gain amplifiers. The contrast adjustment allows to cover a typical range of 38dB.
	BRT7 — BRT0 (BitF — 8)	The brightness adjustment controls to add the same black level (pedestal) to the 3-channel R/G/B signals after contrast amplifier.
V-AMP Control Registers - 1 (Row 16, Column 01)	RSB7 — RSB0 (Bit7 — 0)	R channel SUB contrast control. The SUB contrast adjustment is used to adjust the white balance, and the gain of each channel is controlled. The SUB contrast adjustment allows you to cover a typical tange of 12dB.
	GSB7 — GSB0 (BitF — 8)	G channel SUB contrast control. The SUB contrast adjustment is used to adjust the white balance, and the gain of each channel is controlled. The SUB contrast adjustment allows you to cover a typical tange of 12dB.
V-AMP Control Registers - 2 (Row 16, Column 02)	BSB7 — BSB0 (Bit7 — 0)	B channel SUB contrast control. The SUB contrast adjustment is used to adjust the white balance, and the gain of each channel is controlled. The SUB contrast adjustment allows you to cover a typical tange of 12dB.
	OSD7 — OSD0 (BitF — 8)	The OSD contrast adjustment is made by contrdling simultaneously the gain of three internal variable gain amplifiers. The OSD contrast adjustment allows to cover a typical range of 38dB.
V-AMP Control Registers - 3 (Row 16, Column 03)	RWB7 — RWB0 (Bit7 — 0)	R channel cut-off control. The cut-off adjustment is used to adjust the raster white balance.
	GWB7 — GWB0 (BitF — 8)	G channel cut-off control. The cut-off adjustment is used to adjust the raster white balance.
V-AMP Control Registers - 4 (Row 16, Column 04)	BWB7 — BWB0 (Bit7 — 0)	B channel cut-off control. The cut-off adjustment B used to adjust the raster white balance.
	CUT7 — CUT0 (BitF — 8)	The cut-off brightness adjustment is made by simultaneously controlling the external cut-off current.

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Tabel 4. Register Description (Continued)

Registers	Bits	Description
V-AMP Control Registers - 5 (Row 16, Column 05)	HT (Bit 0)	Video & OSD half tone enable. If you set this bit to '1', the half tone function is on. Then you can see the video signal & OSD raster.

HG1 — HB1 (Bit3 — 1): HG1 — HB1 bits select OSD raster color 1 to be half tone. To carry out half tone function, set the HT bit to '1'.

HG1	HR1	HB1	OSD			Raster Color 1	POR
			G	R	B		
0	0	0	0	0	0	Black	O
0	0	1	0	0	1	Blue	
0	1	0	0	1	0	Red	
0	1	1	0	1	1	Magenta	
1	0	0	1	0	0	Green	
1	0	1	1	0	1	Cyan	
1	1	0	1	1	0	Yellow	
1	1	1	1	1	1	White	

HG2 — HB2 (Bit6 — 4): HG2 ~ HB2 bits select OSD raster color 2 to be half tone. To carry out half tone function, set the HT bit to '1'.

HG2	HR2	HB2	OSD			Raster Color 2	POR
			G	R	B		
0	0	0	0	0	0	Black	O
0	0	1	0	0	1	Blue	
0	1	0	0	1	0	Red	
0	1	1	0	1	1	Magenta	
1	0	0	1	0	0	Green	
1	0	1	1	0	1	Cyan	
1	1	0	1	1	0	Yellow	
1	1	1	1	1	1	White	

SB (Bit 7): Soft blanking enable. If you set this bit '1', the R/G/B outputs go to GND.

Tabel 4. Register Description (Continued)

	Bits	Description
Registers - 5 (Row 16,	HG3 — HB3 (BitA — 8)	To carry out half tone function, set the HT bit to '1'.

	HR3	HB3	G	R		Raster Color 3	
1	0		0	0		Black	
1		1	0		1	Blue	
	1	0		1	0		
1	1		0	1		Magenta	
0		0	1		0	Green	
0	0		1	0		Cyan	
0		0	1		0	Yellow	
	1	1		1	1		

	Bits	Description
	CS2 — CS1	Cut-off offset current control

CS2	CS1		POR
0		100μ	
0	1	μA	
	0	0 A	O
	1	50 A	

	Bits	Description
	BLKP	Polarity of horizontral fly back signal If this bit is '0', HFLB's polarity is negative, and if '1', it is positive.
	(Bit E)	Polarity of clamp pulse signal This bit has meaning only if the CLPS bit is set to '1'.
	CLPS	Clamp pulse generation enable If this bit is '0', clamp signal is made using the HFLB signal, so there is and if '1' you must supply external clamp signal.

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VIDEO AMP PART ADDRESS MAP

Register sub address

Table 12. Video AMP Part Address Map

SUB Address [Hex]	Function																POR Value [Hex]
	F	E	D	C	B	A	9	8	7	6	5	4	3	2	1	0	
1000	Brightness control								Contrast control								8080
1001	SUB contrast control (G)								SUB contrast control (R)								8080
1002	OSD contrast control								SUB contrast control (B)								8080
1003	Cut-off control (G)								Cut-off control (R)								8080
1004	Cut-off brightness control								Cut-off control (B)								8080
1005	CLPS	CLPP	BLKP	CS2	CS1	HG3	HR3	HB3	SB	HG2	HR2	HB2	HG1	HR1	HB1	HT	1800

Contrast Register (SUB ADRS: 00H) (Vin = 0.7Vpp, bright: 80H, subcont: FFH)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	Contrast (Vpp)	Gain (dB)	int. Value (Hex)
00	0	0	0	0	0	0	0	0	0	-	
80	1	0	0	0	0	0	0	0	2.85	-	O
FF	1	1	1	1	1	1	1	1	5.2	-	
Increment/bit									0.0223		

Brightness Register (3-ch) (SUB ADRS: 00H) (cont: 80H, subcont: 80H)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	Brightness (Vpp)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0	0.2	
80	1	0	0	0	0	0	0	0	1.5	O
FF	1	1	1	1	1	1	1	1	2.7	
Increment/bit									0.01055	

SUB Contrast Register (R/G/B-ch) (SUB ADRS: 01/02H)

(Vin = 0.7Vpp, bright: 40H, cont: FFH)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	SUB Contrast (Vpp)	Gain (dB)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0		-	
80	1	0	0	0	0	0	0	0		-	O
FF	1	1	1	1	1	1	1	1		-	
Increment/bit											

OSD Contrast Register (SUB ADRS: 02H) (VOSD = TTL, bright: 80H, subcont: 80H)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	OSD Contrast (Vpp)	Gain (dB)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0	0	-	
80	1	0	0	0	0	0	0	0	3.2	-	O
FF	1	1	1	1	1	1	1	1	6.4	-	
Increment/bit									0.025		

Cut-Off Brightness Register (3-ch) (SUB ADRS: 04H)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	Cut-Off Brightness (μA)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0	0	
80	1	0	0	0	0	0	0	0	100	O
FF	1	1	1	1	1	1	1	1	200	
Increment/bit									0.781	

Cut-Off Register (R/G/B-ch) (SUB ADRS: 03/04H)

(cont = 80H, subcont: 80H)

Hex	B7	B6	B5	B4	B3	B2	B1	B0	Cut-Off EXT (μA)	Int. Value (Hex)
00	0	0	0	0	0	0	0	0	0	
80	1	0	0	0	0	0	0	0	300	O
FF	1	1	1	1	1	1	1	1	600	
Increment/bit									2.344	

ADDRESSING

- **ROM Fonts**
  S1D2514X01 provides 256 Rom fonts for displaying OSD Icons, which allows the use of multi-language OSD Icons. Font $000 is reserved for blank data.
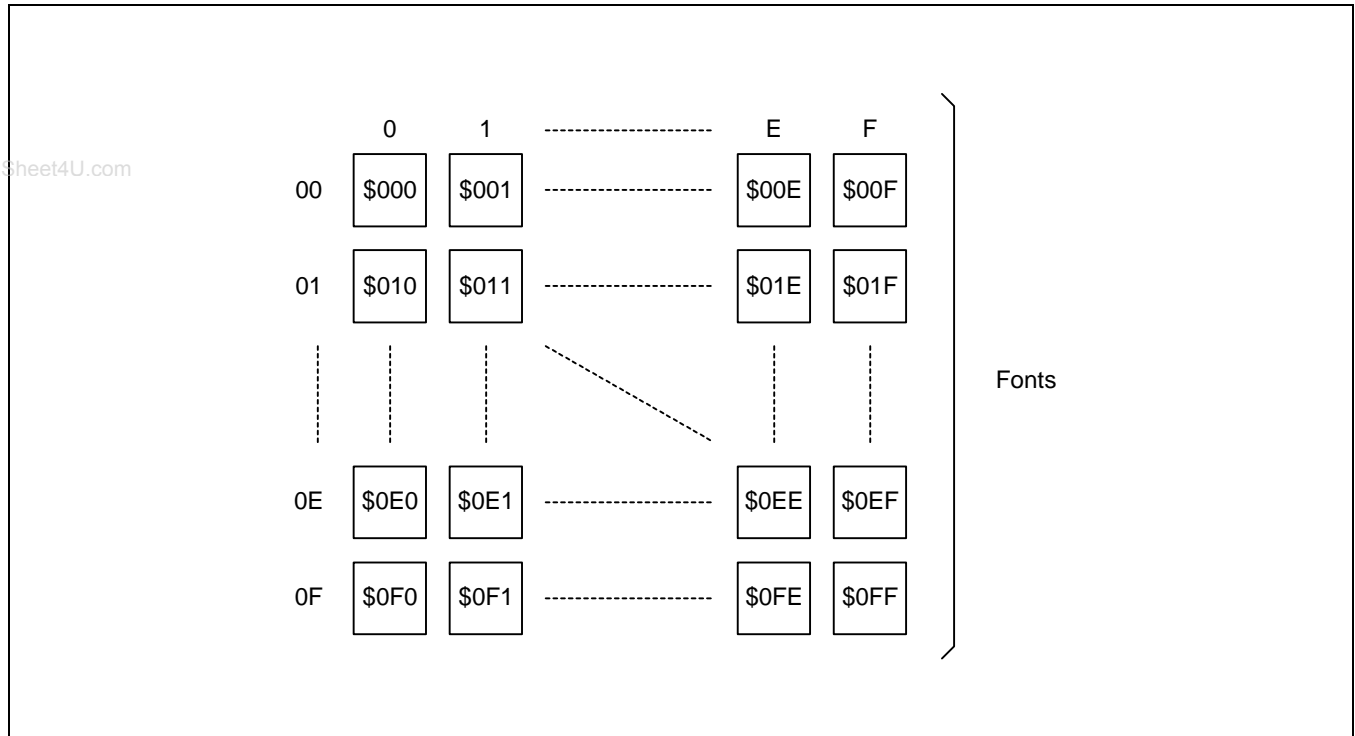

Figure 11. Composition of the ROM Fonts

COLORING

If you have an Intensity feature, the number of possible colors you can express becomes doubled. In other words, the number of colors you can represent with three colors blue, green, and red is 8 ($= 2^3$), but with the intensity feature, it is 16 ($= 2^4$).

- **Character Color**
  Character color is assinged for each font, and the 4 components for expressing a color are listed below.

Blue	Character & attribute register's CB bit[A]
Green	Character & attribute register's CG bit[9]
Red	Character & attribute register's CR bit[8]
Intensity	If the EX-EN bit is '1' and the Frame Control Register 3 CTLs̓ CINT bit called by Character & Attribute registers̓ Blink, SHA bits is '1', the character intensity feature is enabled.

- **Raster Color**

Blue	Character & Attribute register's RB bit[D]
Green	Character & Attribute register's RG bit[C]
Red	Character & Attribute register's RR bit[B]
Intensity	If the EX-EN bit is '1' and the Frame Control Register 3 CTLs̓ RINT bit called by Character & Attribute registers̓ Blink, SHA bits is '1', the RASTER intensity feature is enabled.

According to the 'EX-EN', 'RINT' and 'CINT' bits setting, raster and character color intensity can be assigned in units of character.

Notes for When Making S1D2514X01 Fonts
Address 000h is appointed as blank data. RAM's initial values are all 0, and all bits are written as 0 when you erase the RAM, so blank data means the initial value. In other words, blank data means 'do nothing'. You don't need to write any data for the space font, except for 000h. It just needs to be an undotted area.

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• **Other Color Effet**

The Frame Control Register 0 'BGEN' bit's function is shown in the Figure below. If you set the 'BGEN' bit as '0' after selecting A's raster color as black, the raster color black will be displayed. But if you set the 'BGEN' bit as '1', after selecting B's raster color as black, the raster color black becomes invisible, so the video back ground color (gray) is displayed as if it is the raster color.
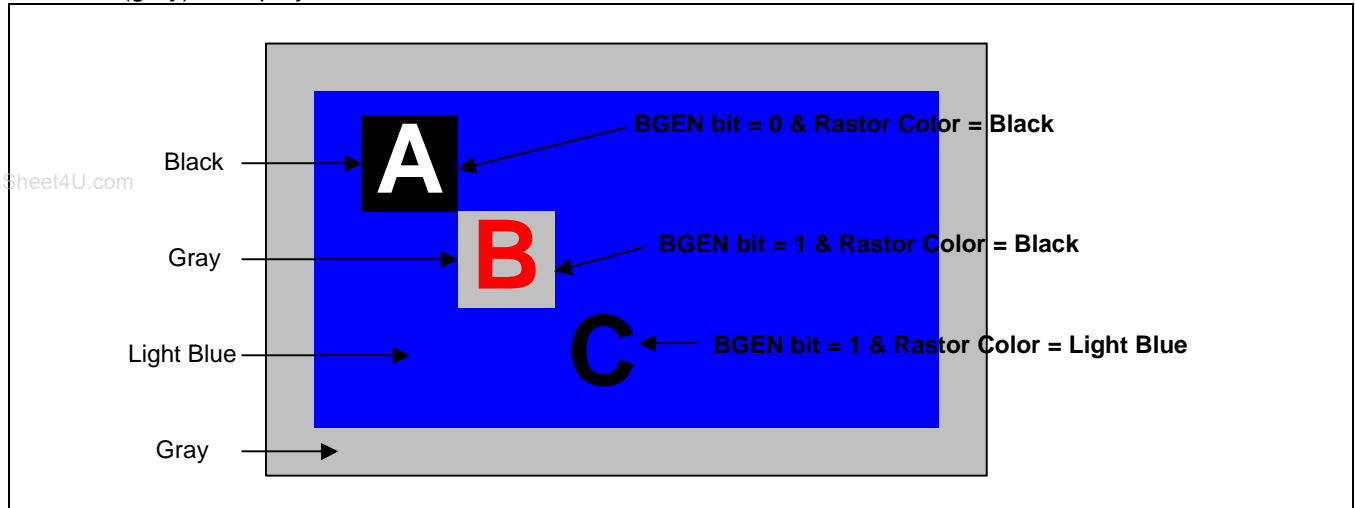

Figure 12. Color Effect by BGEN Bit

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HEIGHT/POSITIONING

• **Character Height**
The purpose of CH[5:0] (Character Height) is to output a uniformly sized OSD even if the resolution changes. To express a Character Height of CH = 18 ~ CH = 63 after receiving CH[5:0]'s input from the frame control register-1, decide on each line's repeating number (Standard Height CH = 18) and repeat the lines.

The following Figure shows two examples of a height-controlled character. height control is carried out by repeating some of the lines.
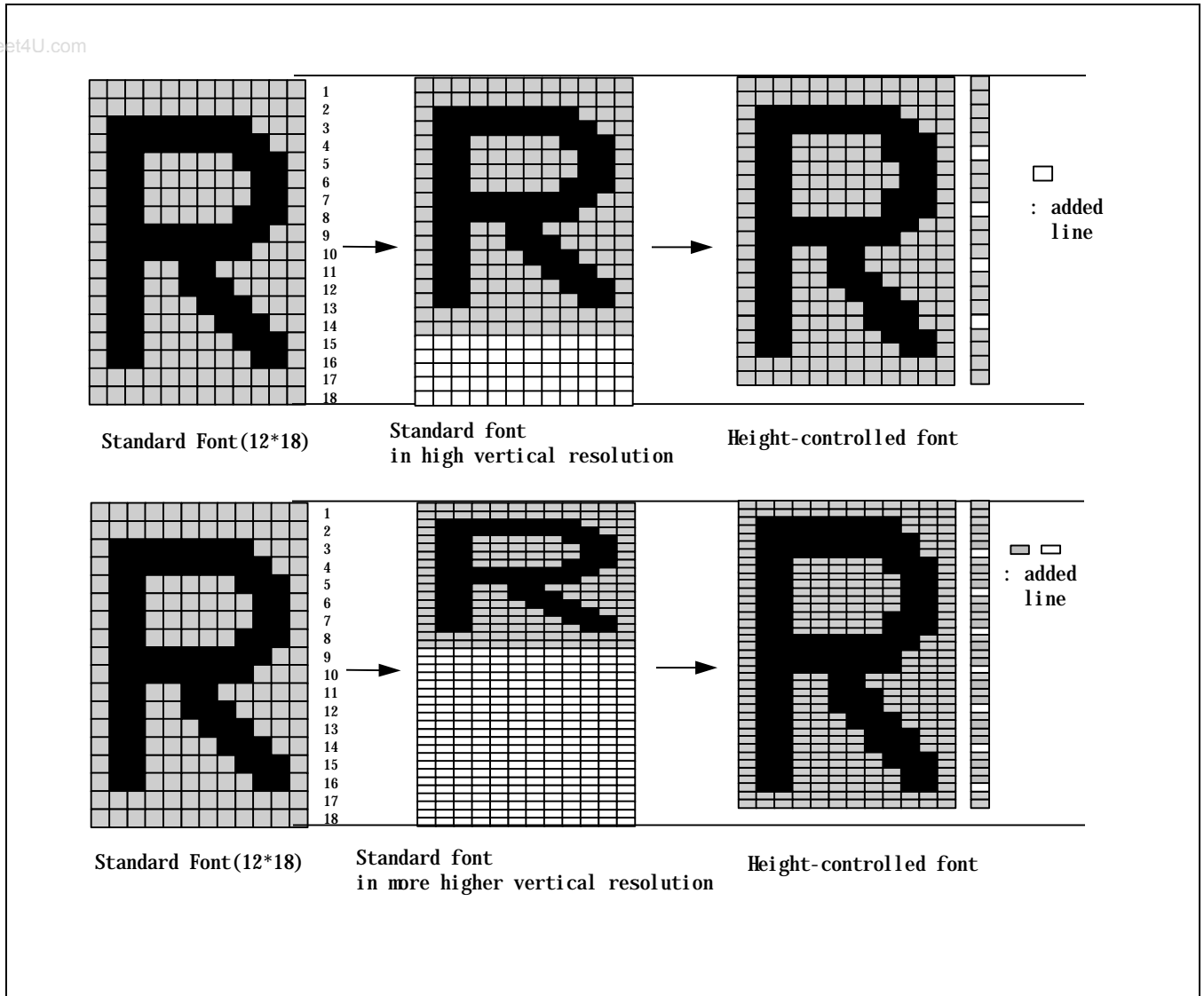
Figure 13. Character Height

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Repeating line-number can be found by the following formula.

> [# of the repeating lines = $2 + N \times M$],
> where $N = 1, 2, 3, ...$ and $M = \text{round}\{14 \div (CH[5:0]-18)\}$.

1. If $CH[5:0]$ is greater than 32 and less than or equal to 46 ($32 < CH[5:0] \leq 46$), all lines are repeated once or twice. The lines that are repeated twice are chosen by the following formula.

> [# of the repeating lines = $2 + N \times M$],
>
> where $N = 1, 2, 3, ...$ and $M = \text{round}\{14 \leq (CH[5:0]-32)\}$.

2. If $CH[5:0]$ is greater than 46 and less than or equal to 60 ($46 < CH[5:0] \leq 60$), all lines are repeated two or three times. The lines that are repeated three times are chosen by the following formula.

> [# of the repeating lines = $2 + N \times M$],
>
> where $N = 1, 2, 3, ...$ and $M = \text{round}\{14 \leq (CH[5:0]-46)\}$.

3. If $CH[5:0]$ is greater than 60 and less than or equal to 64 ($60 < CH[5:0] \leq 64$), all Lines are repeated three or four times. The lines that are repeated four times are chosen by the following formula.

> [# of the repeating lines = $2 + N \times M$],
>
> where $N = 1, 2, 3, ...$ and $M = \text{round}\{14 \leq (CH[5:0]-60)\}$.

CH's reference value is 18, and even if you input 0, it operates in the same way as when $CH = 18$. The repeating line-number is limited to 16. If the M value is less than or equal to 1, all lines of the standard font are repeated more than once.

Table 13. Repeating Line as Controlling by CH bits

Character Height	Repeating Line
CH = 18	-
CH = 19	9
CH = 20, 21	6, 13
CH = 22	5, 11, 17
CH = 23	4, 9, 14, 19
CH = 24	3, 7, 11, 15, 19, 21
CH = 25, 26, 27	3, 7, 11, 13, 15, 19, 22
CH = 28	3, 6, 9, 12, 14, 18, 20, 23, 25
CH = 29	3, 6, 9, 11, 13, 15, 18, 21, 23, 25, 26
CH = 30	3, 6, 8, 10, 12, 14, 16, 18, 20, 22, 25, 27
CH = 31	2, 5, 7, 9, 11, 13, 15, 17, 21, 23, 25, 27, 28
CH = 32, 33, 34, 35	2, 5, 7, 9, 11, 13, 15, 18, 21, 23, 25, 27, 28, 29
CH = 36	-
CH = 37	18

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Table 13. Repeating Line as Controlling by CH bits

Character Height	Repeating Line (Continued)
CH = 38, 39	12, 25
CH = 40	10, 20, 30
CH = 41	8, 16, 24, 32
CH = 42	6, 12, 18, 24, 30, 36
CH = 43, 44, 45	6, 12, 18, 24, 30, 36, 41
CH = 46	4, 8, 12, 17, 21, 25, 29, 33, 37, 41
CH = 47	4, 8, 12, 16, 20, 24, 28, 32, 36, 40, 44
CH = 48	4, 8, 12, 16, 20, 23, 26, 29, 33, 37, 41, 45
CH = 49	4, 8, 12, 16, 19, 22, 25, 28, 31, 35, 39, 43, 47
CH = 50, 51, 52, 53	4, 8, 12, 15, 18, 21, 24, 27, 30, 33, 36, 40, 44, 48
CH = 54	-
CH = 55	27
CH = 56, 57	18, 36
CH = 58	14, 28, 42
CH = 59	12, 23, 34, 45
CH = 60	9, 18, 26, 34, 43, 52
CH = 61, 62, 63	8, 16, 23, 30, 37, 44, 51

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- **Positioning**
  The frame control register-2's HP Bit [F:8] signifies delay of the horizontal display from the H-Sync reference edge to the character's 1st pixel location, and is controlled by multiplying HP [F:8]'s range value by 6. Also, VP bit[7:0] signifies the top margin height from the V-Sync reference edge, and is controlled by multiplying 4 to the VP [7:0]'s range value. Refer to the Figure shown below.
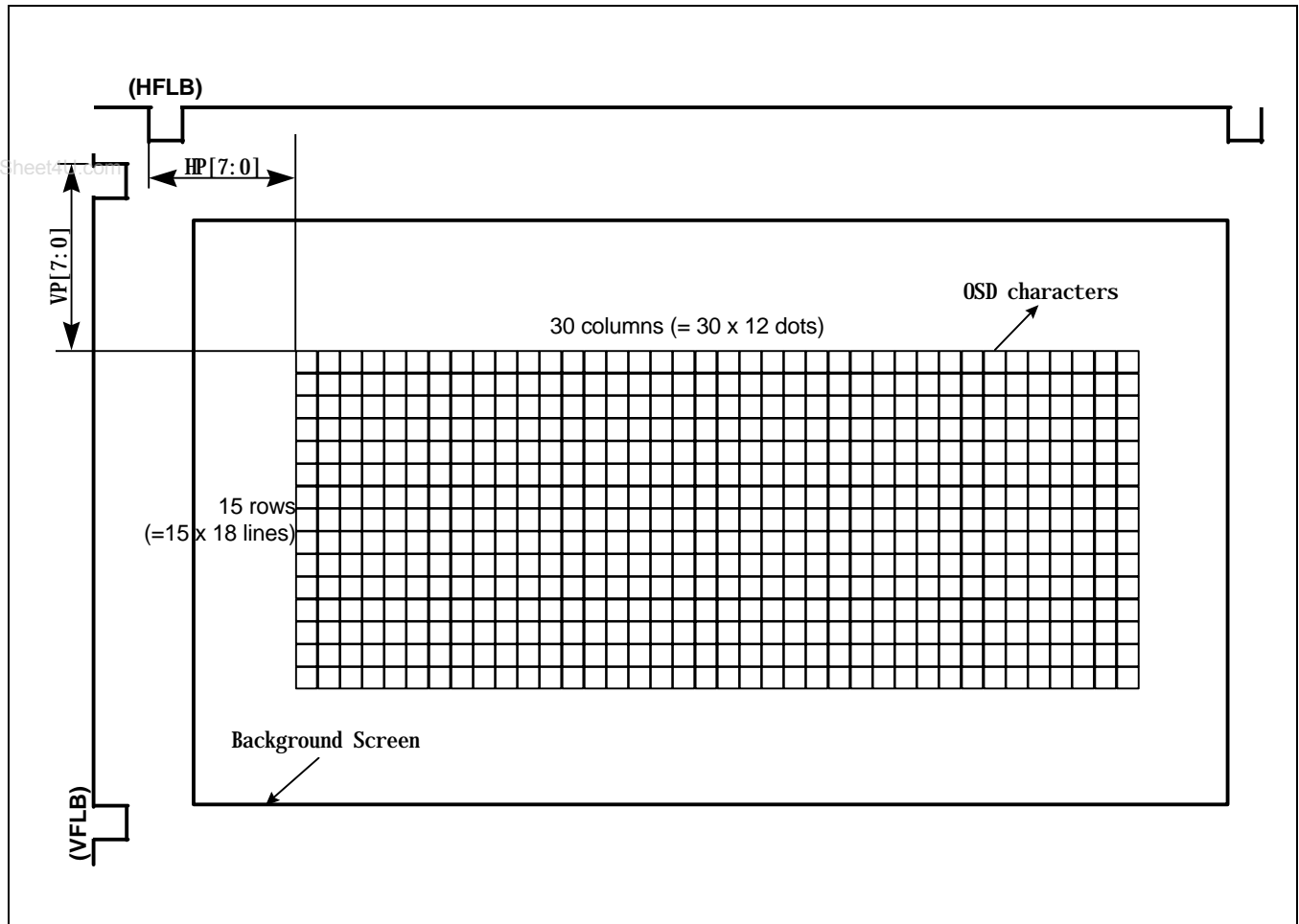

Figure 14. Frame Composition with the OSD Characters

VISUAL EFFECTS

- **Shadowing**
  The character shadow can only be black. Character shadow is making 1 pixel to the right and below the character.
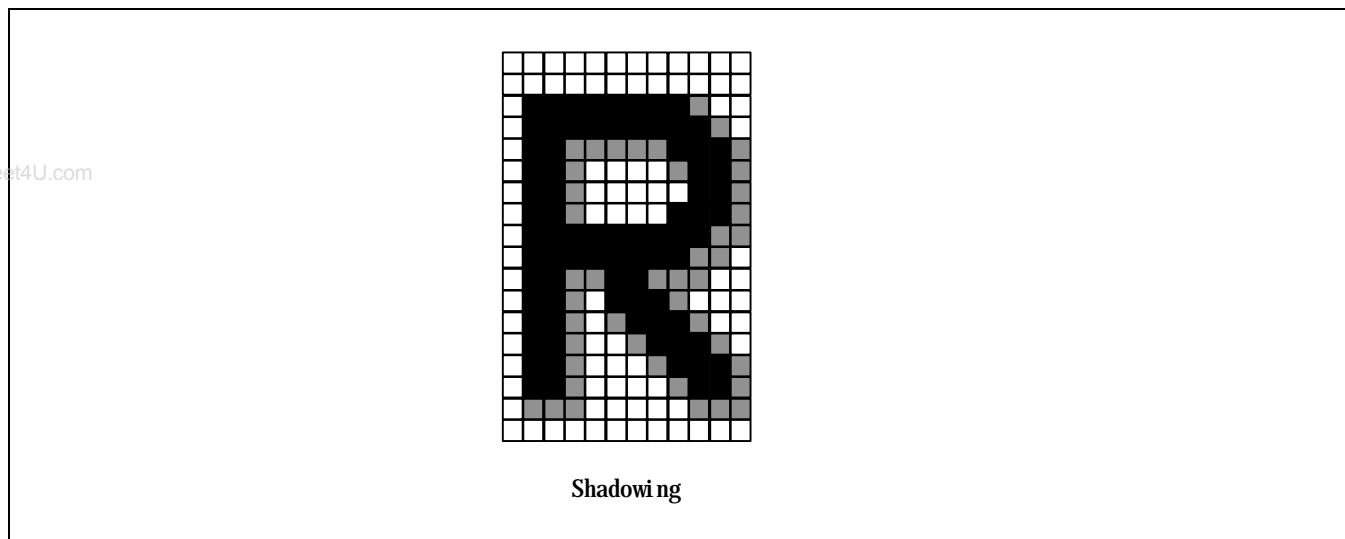
Shadowing

Figure 15. Character Shadowing

- **Scrolling**
  Scrolling is slowly displaying or erasing a character from the top line to the bottom. This effect makes it look as if 1 character line is scrolling up or down. asharacter line is scrolling up or down.
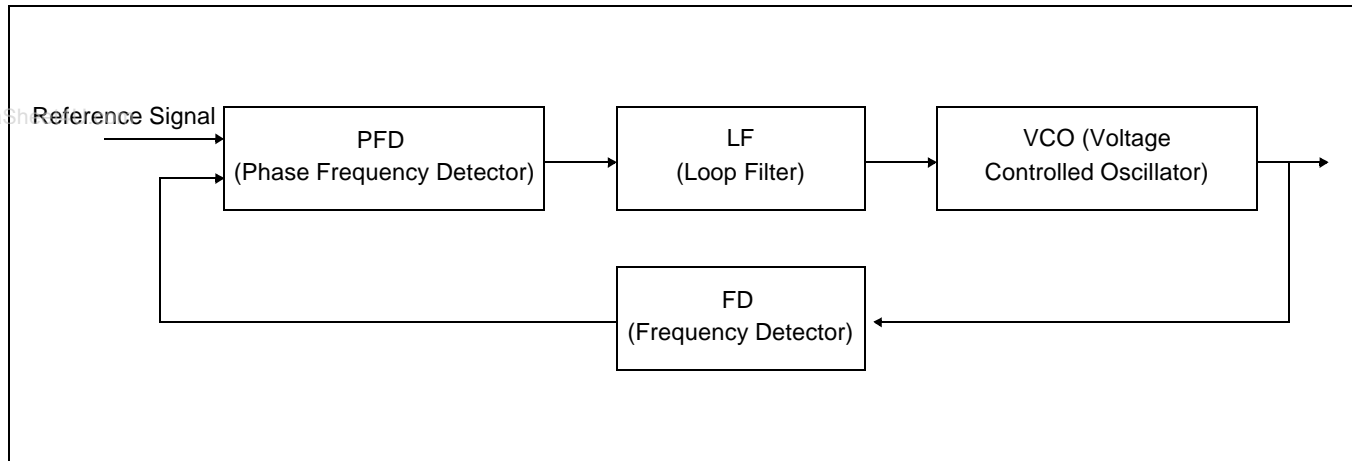

Figure 16. Scrolling

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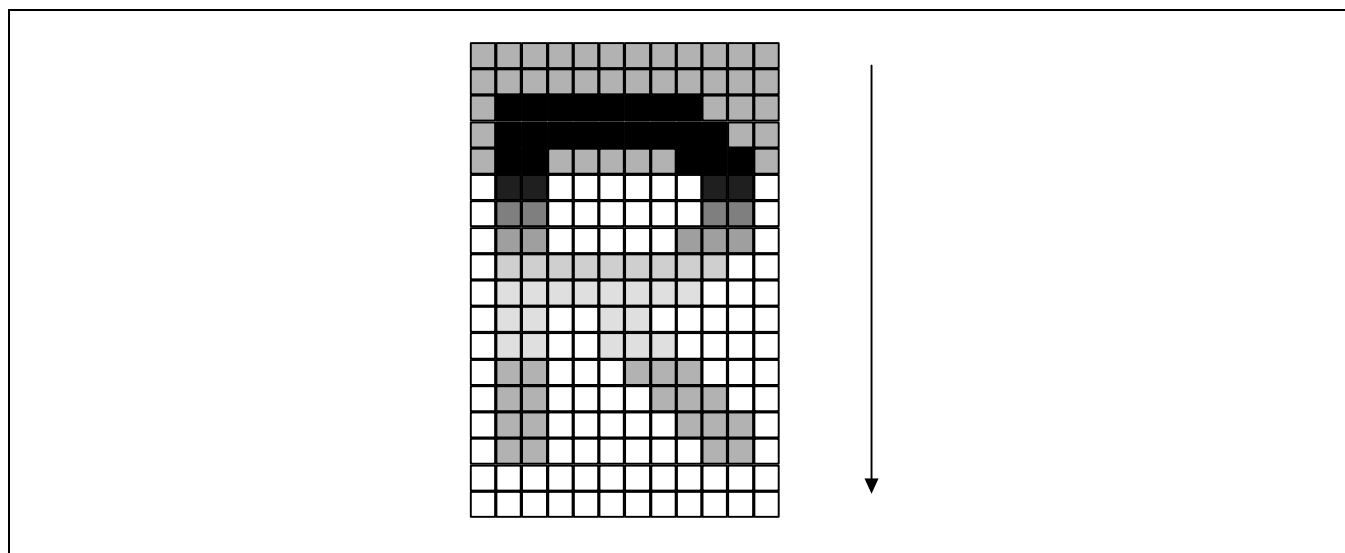
PLL CONTROL

- **Introduction**
  PLL (Phase Lock Loop) is feedback controlled circuit that maintains a constant phase difference between a
  reference signal and an oscillator output signal.

  Generally, PLL is composed as follow Figure.

Figure 17. Block Diagram of General PLL

- PFD (Phase Frequency Detector)
  PFD compares the phase of the VCO output frequency, with the phase of a reference signal frequency output
  pulse is generated in proportion to that phase difference.

- LF (Loop Filter)
  LF smooths the output pulse of the phase detector and the resulting DC component is the VCO input.

- VCO (Voltage Controlled Oscillator)
  VCO is controlled by loop filter output. The output of the VCO is fed back to the phase frequency detector
  input for comparison which in turn controls the VCO oscillating frequency to minimize the phase difference.

- FD (Frequency Divider)
  FD divides too much different frequency that is oscillated from the VCO to compare it with reference signal
  frequency.

- **PLL of the S1D2514X01**
  PLL is composed of the phase detector, charge pump, VCO, and N-divider as 4 sub-blocks.
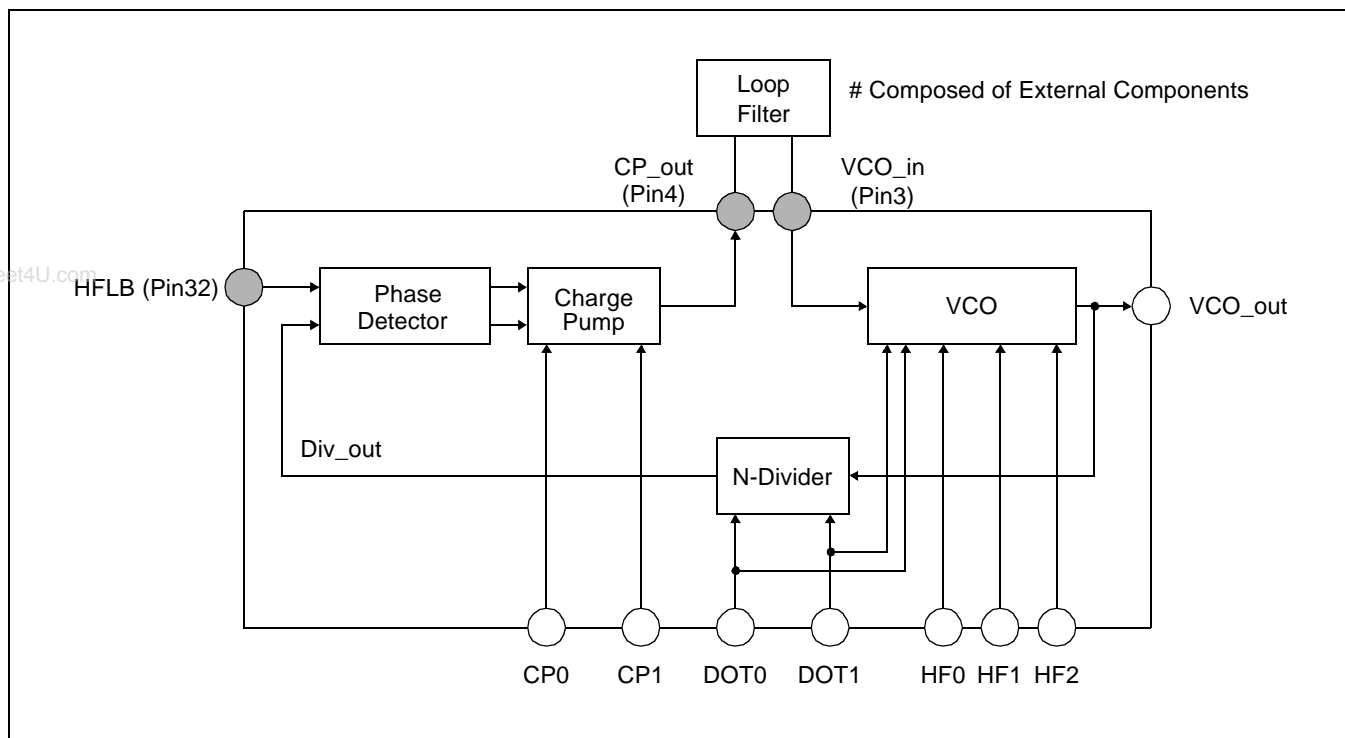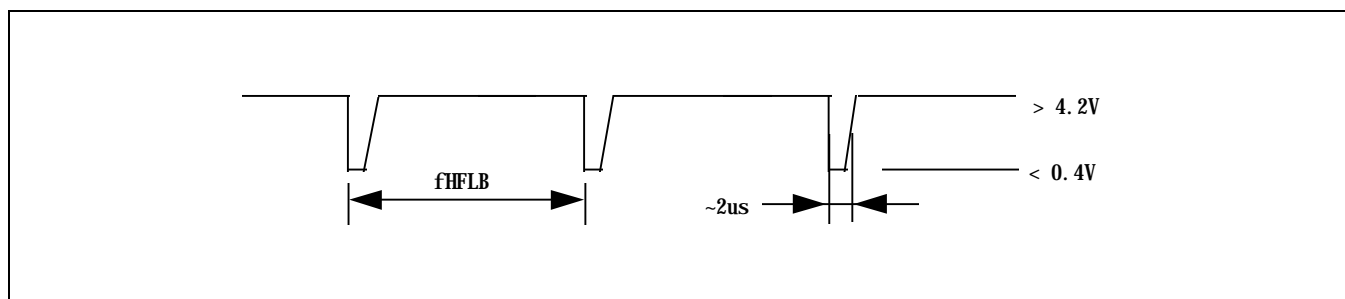

Figure 18. Block Diagram of the PLL Built in S1D2514X01

The following is the description of the input/output signals.

- **HFLB (Input)**
  Horizontal flyback signal is refrence signal of the PLL built in S1D2514X01.
  The HFLB signal's frequency range is 15 ~ 90kHz, so the PLL block must be a wide range PLL that can cover
 HFLB's entire frequency range.

- VCO (Input)
  Error signal that passes through an external loop filter is input into VCO.
  Operation voltage range is 1-4V. You can raise immunity towards external noise by lowering VCO
  sensitivity. You can do this by making it have the maximum operation voltage range possible in the 5V power
  voltage.

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- DOT0, 1 (Input)
Mode control signal that controls the number of dots per line in the frame control register. There are 4 modes: 320, 480, 640, and 800 dots/line.
According to your choice of mode, the OSD_PLL block's N-Divider is controlled by one of ÷320, ÷480, ÷640, or ÷800 Divider.

- HF0, 1, 2 (Input)
The horizontal Sync frequency information is received from the micro controller through the frame control registers-1's bit C-A.

- CP0, 1 (Input)
Charge Pump's output sourcing (or sinking) current control pin.
This control data is received through frame control registers-1's bits E-D.

- VCO_OUT (Output)
VCO output that becomes a system clock. It is the OSD R, G, B output signal's dot frequency, and the standard signal for OSD's various timings.
Also, it is input into the N-Divider and makes a PLL loop
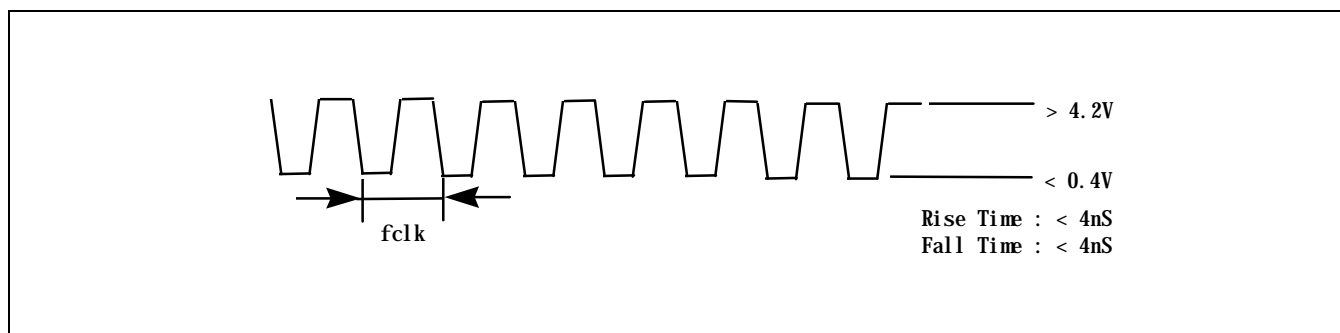
- CP_OUT (Output)
Charge Pump circuit's output. input into external loop filter. It becomes one of 3 states according to the standard signal input into the phase detector (HFLB) and the divider output (Div_Out).

  - HFLB Div_Out is lead: Current sink

  - HFLB Lag: Current source

  - HFLB In-Phase: High impedence

TUNNING FACTORS OF THE S1D2514X01 PLL

- **PLL External Circuit**
  You may follow the recommendations for PCB art work and input/output signal characteristic improvement in recommendation.

  The external circuit that has the most influence on S1D2514X01 PLL block operation is pin 3 (VCO_IN) and pin 4 (CP_OUT)'s surrounding circuit. Refer to OSD PLL block.
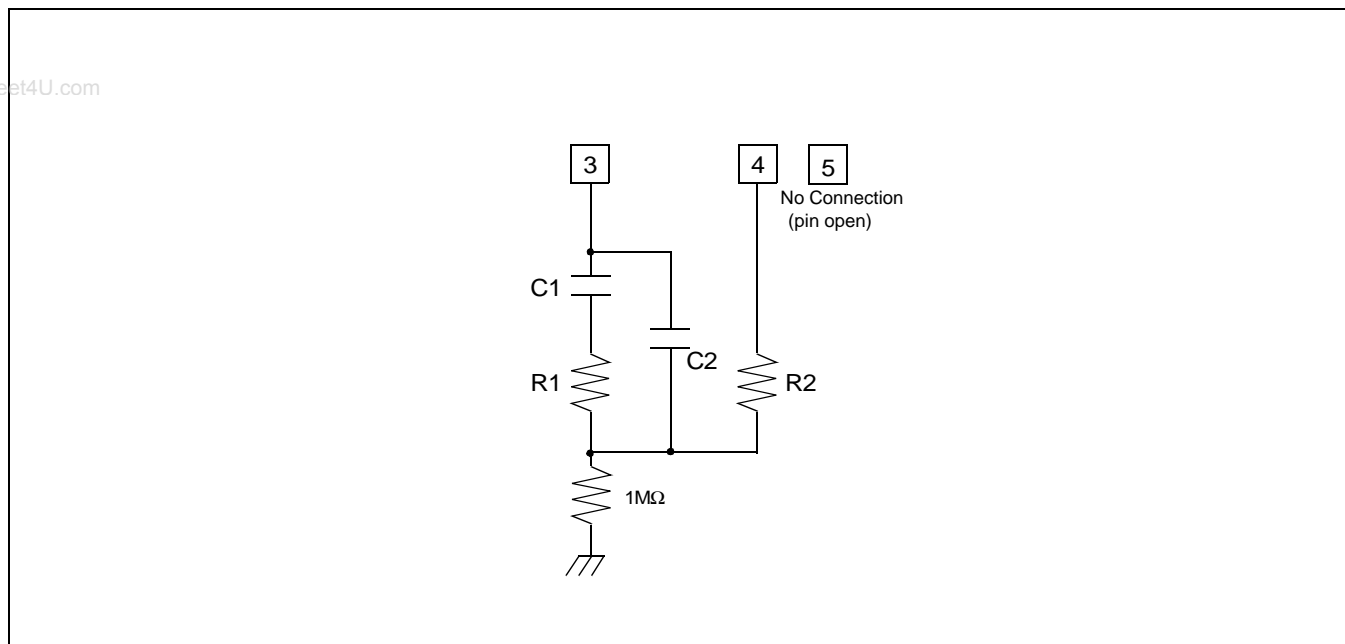
Figure 19. PLL External Circuit

Because the PLL circuit is basically a feedback circuit, there are many components that influence the characteristics. C1, C2, R1, and R2 do not have a localized effect.

As you can see, they are connected to the PLL control bits and influence the characteristics through their complicated relationships. The main functions of the time canstant and their reference values are as follows.

Table 14. Main Function of Time Constant in PLL External Circuit

Time Canstant	Recommended Value	Main Function
C1	10uF	Influences the damping ratio and controls the PLL response time
R1	5.6KΩ(7.5KΩ)	Same as C1
R2	27KΩ (or 33KΩ)	Charge pump current adjustment
C2	33pF	Removes ripple caused by R-C circuit

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- **PLL Control Bit**
  After configuring an external circuit using the recommended values, carry out programming using the
  recommended values for frequency range and control bits given in the Table below.

Table 15. Recommend Values of PLL Control Bit

Register Set	PLL Control Bit								
Freq. Range	CP1	CP0	FPLL	HF2	HF1	HF0	DOT1	DOT0	Hex
Below 40kHz	0	0	0	0	1	0	1	1	0B
40 - 50kHz	1	0	0	1	0	0	1	1	93
50 - 70kHz	1	1	0	1	0	1	1	1	A7
Above 70kHz	1	1	0	1	1	1	1	1	AF

(Ref: 800×600, C1: 10uF, R1: 5.6K, R2: 27K, C2: 33pF)

- **Locking Range**
  As you can see the figure below, it is 2.35V that measured voltage at pin-3 to optimize OSD quality. The proper
  voltage range is 1.5 — 3.25V.
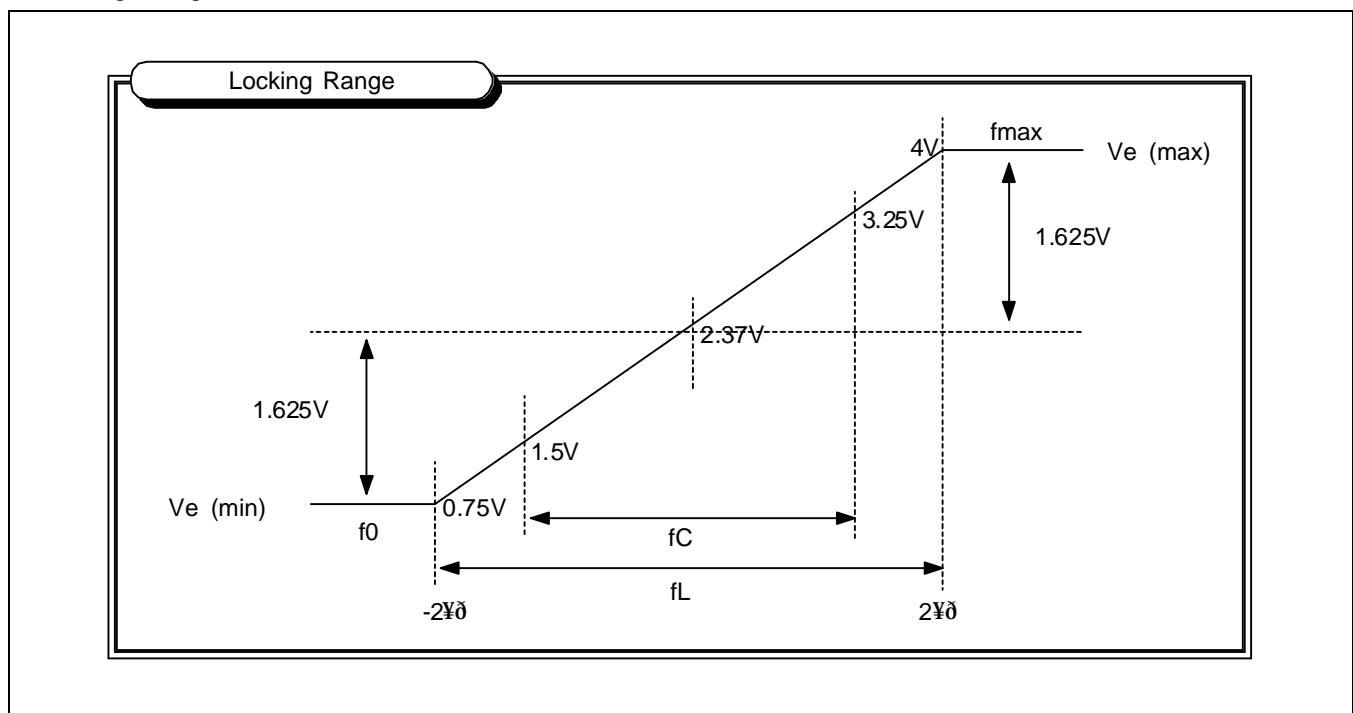
Figure 20. Locking Range

- **HF Bits Selection**
  HF bits is not selecting from out of 8 (2^3) steps uniformly, but selecting the step shown in figure below. In example, at 800 mode, there are 5 steps that the frequency range is controlled by HF bits.

Table 16. HF Bits Selection

DIV	DOT1	DOT0	HF2	HF1	HF0
320	0	0			
480	0	1			
640	1	0			
800	1	1			

After fixing time constants of the external circuit and PLL control bits except HF bits, if HF bits are stepped up, the voltage measured at pin-3 drops. On the contrary, if HF bits are stepped down, the voltage rises.

The voltage measured at pin-3 don't change by changing CP bits.

- **External Register at pin-4**

The external register at pin-4 is the factor that changes greatly at PLL tunning. The initial value of this external register value is decided as follows.

At first, the external register is replaced variable-register (about 50KΩ range).

and then, set the lowest PLL control bits at the lowest frequency allowed by set.
and then, change variable-register to be 2.35V that optimum voltage is locking.
and then, measure register value at this time.

also, set the highest PLL control bits at the highest frequency allowed by set.

and then, change variable-register to be 2.35V that optimum voltage is locking.
and then, measure register value at this time.

You may decide the average of these two registers' value to initial value.

The table below shows that other factors change as changing external register's value.

Fixing Factor	Variable Factor	Change	Voltage	Current	Lock Range
Time constants of the external circuit and PLL control bits except	Rext	↑	↑	↓	↓ (shift)
		↓	↓	↑	↑ (shift)

RECOMMENDATION

5V Power Routing

S1D2514X01's OSD part power is composed of analog VDD and digital VDD. To eliminate clock noise influence in the digital block, you need to separate the analog VDDA and digital VDD.

(BD102 use: Refer to Application Circuit)

12V Power Routing

Because S1D2514X01 is a wideband AMP of above 150MHz, 12V power significantly affects the video characteristics. The effects from the inductance and capacitance are different for each board, and , therefore, some tuning is required to obtain the optimum performance. The output power, VCC2, must be separated from VCC1 and VCC3 using a coil, which is parallel-connected to the damping resistor.The appropriate coil value is between 20uH - 200uH. Parallel-connected a variable resistor to the coil and control its resistance to obtain the optimum video waveform.

(Moreover, BD103 can tune using a coil and variable resistor to obtain the optimum video waveform. L103, R124, BD103: Refer to application circuit)

VCC1, VCC3 12V Power

Use a 104 capacitor and large capacitor greater than 470uH for the power filter capacitor.

12V Output Stage Power VCC2

Do not use the power filter capacitor.

5V Digital Power VDD

Don't use a coil or magnetic core to the VDD input. Make the power filter capacitor, an electric capacitor of greater than 50uF, single and connect it to VSS, the digital GND.

Output Stage GND2

Care must be taken during routing because it ,as an AMP output stage GND, is an important factor of video oscillation. R/G/B clamp cap and R/G/B load resistor must be placed as close as possible to the GND2 pin. GND2 must be arranged so that it has the minimum GND loop, which at one point must be connected to the main GND.

Digital GND VSS

When this is to be connected directly to the GND2, it can cause the OSD clock noise, so the loop connection should be routed as far away as possible. If the OSD clock noise affects the screen, separate VSS GND from all GND and connect it to the main board using a bead. Again, the bead connection point should be placed as far away as possible to the GND2.

Analog Block

The PLL built in to S1D2514X01 is sensitive to noise due to the wide range PLL characteristics. Therefore, you need to isolate the analog block in the following manner. First make a separate land for the analog block (pin2 - pin6)'s ground, and connect it to the main ground through a 1MΩ resistor. The analog GND of both sides of a double faced PCB must be separated from the main ground. (Separate pin 2's 5V analog GND, which is the GND for OSD PLL, from the main and digital GNDs and connect it to the main GND using about 1MΩ resistor. GND for pins 2 - 6 is the No. 2 VSSA GND.)

I²C Control Line (SCL, SDA Line)

I²C communication noise (noise generated in the OSD display pattern when data is transmitted in the I²C line) may be generated because of an I²C control line that passes near the analog block. The I²C control lines near S1D2514X01 must be separated from the analog block as much as possible.

Furthermore, the I²C bus interference can be prevented by inserting a series resistor in the line.

Horizontal Flyback Signal

Display jittering can be generated if the horizontal signal (HFLB) input to S1D2514X01 is not a clean signal.
We recommend a short path and shielded cable for obtaining a clean signal.

Generally, the input horizontal signal (HFLB) is generated by using a high voltage horizontal flyback signal. The effect from the high voltage flyback signal can be reduced by separating the R115 and R117 GND, which determines the flyback signal slice level, from the transistor GND, which generates the actual S1D2514X01 input horizontal signal. Furthermore, the flyback signal sharpness must be maintained by minimizing the values of R115, R116 and R117 resistors, which set the horizontal signal slice level. values.

(R115, R116, R117: Refer to application circuit)

HFLB Input Signal Generator

You can correct the circuit by reducing the resistors that sets the slice level of the horizontal signal in the HFLB-generating circuit.
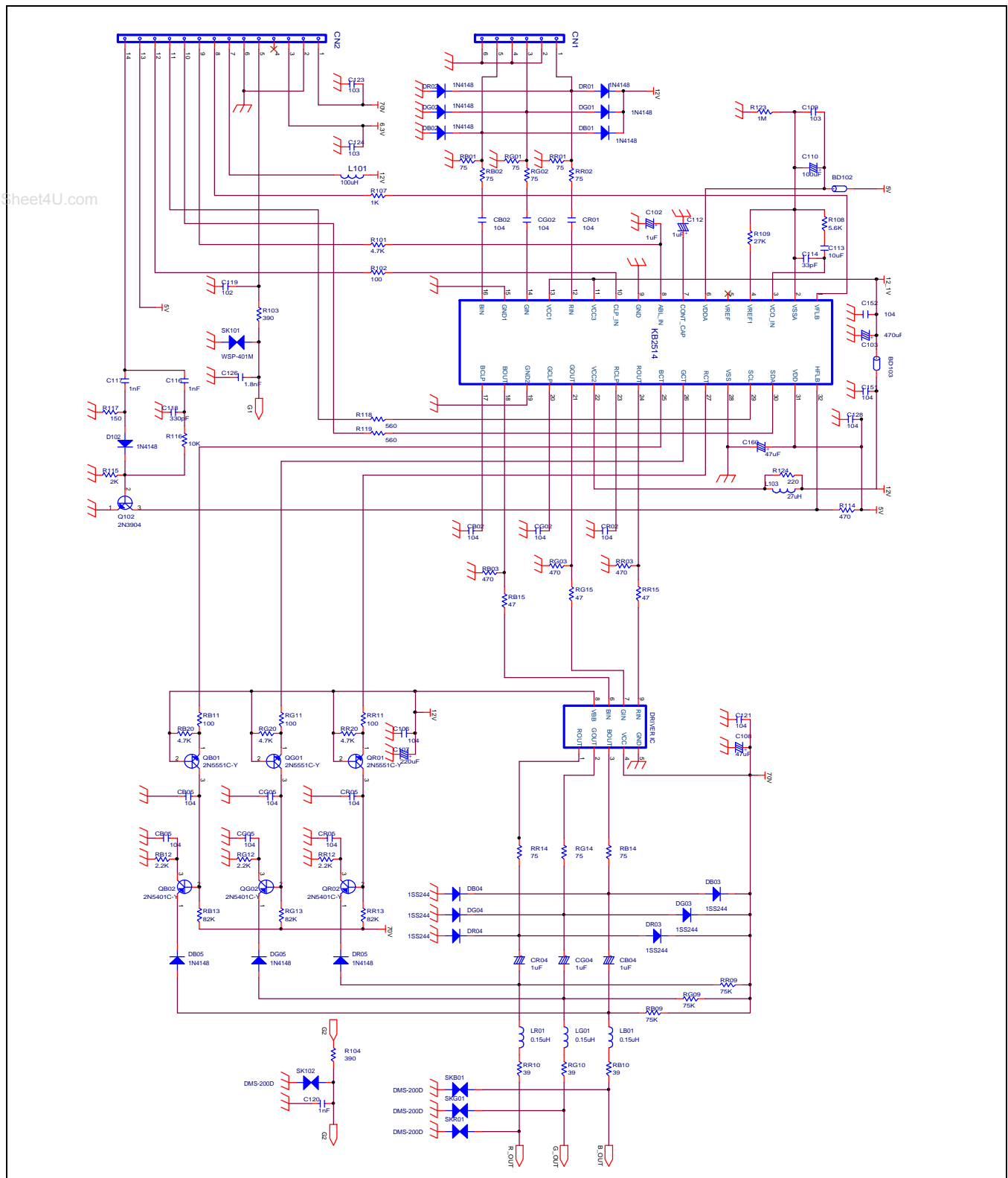
APPLICATION BOARD CIRCUIT

Figure 21. Application Board Circuit

TYPICAL APPLICATION CIRCUIT

Figure 22. Typical Application Circuit

ROM FONTS

Figure 23. ROM Fonts

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